

Sitronix

ST7533

33 x 96 Dot Matrix LCD Controller/Driver

FEATURES

- Direct display of RAM data through the display data RAM.
- RAM capacity: 33 x 96 = 3168 bits
 Display duty selectable by select pin
 - 1/33 duty: 33 common x 96 segment 1/17 duty: 17 common x 96 segment
- High-speed 8-bit MPU interface (The chip can be connected directly to the both the 80x86 series MPUs and the 68000 series MPUs)
 /Serial interfaces are supported.
- Abundant command functions
 Display data Read/Write, display ON/OFF, Normal/
 Reverse display mode, page address set, display start
 line set, column address set, status read, display all
 points ON/OFF, LCD bias set, electronic volume,
 read/modify/write, segment driver direction select,
 power saver, static indicator, common output status
- Static drive circuit equipped internally for indicators.
 (1 system, with variable flashing speed.)

select, V₅ voltage regulation internal resistor ratio set.

- Low-power liquid crystal display power supply circuit equipped internally.
 - Booster circuit (with Boost ratios of 2X/3X/4X, where the step-up voltage reference power supply can be input externally).
 - High-accuracy voltage adjustment circuit (Thermal

- gradient –0.15%/°C) V5 voltage regulator resistors equipped internally, V1 to V4 voltage divider resistors equipped internally, electronic volume function equipped internally, voltage follower.
- CR oscillator circuit equipped internally (external clock can also be input)
- Extremely low power consumption Operating power when the built-in power supply is used (an example) 70uA (VDD VSS = VDD VSS2 = 3.0 V, Quad voltage, V5 VDD = 11.0 V).
 Conditions: When displays pattern OFF and the normal mode is selected.
- Power supply operate on the low 1.8 voltage Logic power supply VDD – VSS = 1.8V to 3.3V (+10% Range) Boost reference voltage: VDD – VSS2 = 1.8V to 3.3V Booster maximum voltage limited VOUT= -13V (+10% Range) Liquid crystal drive power supply: VDD – V5 = 4.0V to 13.0 V
- Wide range of operating temperatures: –40 to 85°C
- CMOS process
- These chips not designed for resistance to light or resistance to radiation.

GENERAL DESCRIPTION

The ST7533 is a single-chip dot matrix LCD drivers that can be connected directly to a microprocessor bus. 8-bit parallel or serial display data sent from the microprocessor is stored in the internal display data RAM and the chip generates a LCD drive signal independent of the microprocessor. Because the chips in the ST7533 contain 33x96 bits of display data RAM and there is a 1-to-1 correspondence between the LCD panel pixels and the internal RAM bits, these chips enable displays with a high degree of freedom. The ST7533 chips contain 33 common output circuits and 96 segment output circuits, so that a single chip can drive a 33x96 dot display (capable of displaying 8 columnsx4 rows of

a 16x16 dot kanji font).

Moreover, the capacity of the display can be extended through the use of master/slave structures between chips. The chips are able to minimize power consumption because no external operating clock is necessary for the display data RAM read/write operation. Furthermore, because each chip is equipped internally with a low-power LCD driver power supply, resistors for LCD driver power voltage adjustment and a display clock CR oscillator circuit, the ST7533 can be used to create the lowest power display system with the fewest components for high-performance portable devices.

PART NO.	PART NO. VRS temperature gradient	
ST7533	-0.15%/°C	-2.1V ±0.03V

ST7533 Pad Arrangement

Chip Size: $7240 \,\mu$ m x 1,000 $\,\mu$ m

Origin: Chip Center

Bump Pitch: 69.1 μ m(Min.) Bump Size: PAD No. 001 \sim 005

 Jump Size:
 PAD No. $001 \sim 005$ $49.1 \, \mu$ m x $70.5 \, \mu$ m

 PAD No. $006 \sim 064$ $56 \, \mu$ m x $60 \, \mu$ m

 PAD No. $065 \sim 070$ $51 \, \mu$ m x $60 \, \mu$ m

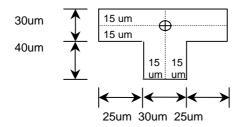
 PAD No. $071 \sim 083$ $56 \, \mu$ m x $60 \, \mu$ m

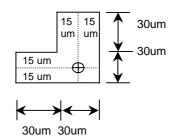
 PAD No. $084 \sim 088$ $49.1 \, \mu$ m x $70.5 \, \mu$ m

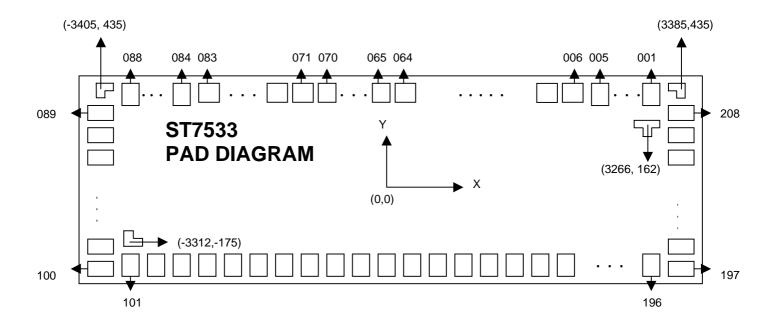
 PAD No. $089 \sim 100$ $70.5 \, \mu$ m x $49.1 \, \mu$ m

PAD No. 101 \sim 196 49.1 μ m x 70.5 μ m PAD No. 197 \sim 208 70.5 μ m x 49.1 μ m

Bump Height: $18 \mu \text{ m(Typ)}$ Chip Thickness: $660 \mu \text{ m}$







ST7533 Pad Center Coordinates (1/33 Duty)

	OCITICI V	Joor an	iates (i
PAD	PIN Name	X	Υ
No.	COMIZO	3290	409
2	COM[28]	3290	409
	COM[29]	3152	409
3	COM[30]		409
	COM[31]	3083	
5	COMS1	3014	409
6	FRS	2919	414
7	FR	2843	414
8	CL	2767	414
9	/DOF	2691	414
10	VSS	2614	414
11	/CS1	2538	414
12	CS2	2462	414
13	VDD	2386	414
14	/RES	2310	414
15	A0	2234	414
16	VSS	2157	414
17	/WR(R/W)	2081	414
18	/RD(E)	2005	414
19	VDD	1929	414
20	D0	1853	414
21	D1	1777	414
22	D2	1701	414
23	D3	1624	414
24	D4	1548	414
25	D5	1472	414
26	D6	1396	414
27	D7	1320	414
28	VDD	1244	414
29	VDD	1168	414
30	VDD	1091	414
31	VSS	1015	414
32	VSS	939	414
33	VSS2	863	414
34	VSS2	787	414
35	VOUT	711	414
36	VOUT	634	414
37	CAP3-	558	414
38	CAP3-	482	414
39	CAP1+	406	414
40	CAP1+	330	414
41	CAP1+	254	414
42	CAP1-		414
		178	414
43 44	CAP2-	101	414
	CAP2-	25	
45	CAP2+	-51 127	414
46	CAP2+	-127	414
47	VSS	-203	414
48	VSS	-279	414
49	VRS	-355	414
50	VDD	-432	414
51	VDD	-508	414
52	V1	-584	414

PAD	PIN Name	V	Y	
No.	PIN Name	Х		
53	V1	-660	414	
54	V2	-736	414	
55	V2	-812	414	
56	V3	-889	414	
57	V3	-965	414	
58	V4	-1041	414	
59	V4	-1117	414	
60	V5	-1193	414	
61	V5	-1269	414	
62	VR	-1345	414	
63	VDD	-1422	414	
64	VDD	-1498	414	
65	TEST0	-1571	414	
66	TEST1	-1642	414	
67	TEST2	-1713	414	
68	TEST3	-1784	414	
69	TEST4	-1855	414	
70	TEST5	-1926	414	
71	VDD	-2000	414	
72	M/S	-2076	414	
73	CLS	-2152	414	
74	VSS	-2228	414	
75	C86	-2305	414	
76	P/S	-2381	414	
77	VDD	-2457	414	
78	/HPM	-2533	414	
79	VSS	-2609	414	
80	IRS	-2685	414	
81	VDD	-2762	414	
82	SEL1	-2838	414	
83	VSS	-2914	414	
84	COM[15]	-3011	409	
85	COM[14]	-3080	409	
86	COM[13]	-3150	409	
87	COM[12]	-3219	409	
88	COM[11]	-3288	409	
89	COM[10]	-3529	351	
90	COM[9]	-3529	282	
91	COM[8]	-3529	213	
92	COM[7]	-3529	144	
93	COM[6]	-3529	75	
94	COM[5]	-3529	6	
95	COM[4]	-3529	-64	
96	COM[3]	-3529	-133	
97	COM[2]	-3529	-202	
98	COM[1]	-3529	-271	
99	COM[0]	-3529	-340	
100	COMS2	-3529	-409	
101	SEG[0]	-3280	-409	
102	SEG[1]	-3211	-409	
103	SEG[2]	-3142	-409	
104	SEG[3]	-3073	-409	

PAD No.	PIN Name	х	Υ
105	SEG[4]	-3004	-409
106	SEG[5]	-2935	-409
107	SEG[6]	-2866	-409
108	SEG[7]	-2797	-409
109	SEG[8]	-2728	-409
110	SEG[9]	-2658	-409
111	SEG[10]	-2589	-409
112	SEG[11]	-2520	-409
113	SEG[12]	-2451	-409
114	SEG[13]	-2382	-409
115	SEG[14]	-2313	-409
116	SEG[15]	-2244	-409
117	SEG[16]	-2175	-409
118	SEG[17]	-2106	-409
119	SEG[18]	-2037	-409
120	SEG[19]	-1967	-409
121	SEG[20]	-1898	-409
122	SEG[21]	-1829	-409
123	SEG[22]	-1760	-409
124	SEG[23]	-1691	-409
125	SEG[24]	-1622	-409
126	SEG[25]	-1553	-409
127	SEG[26]	-1484	-409
128	SEG[27]	-1415	-409
129	SEG[28]	-1346	-409
130	SEG[29]	-1276	-409
131	SEG[30]	-1207	-409
132	SEG[31]	-1138	-409
133	SEG[32]	-1069	-409
134	SEG[33]	-1000	-409
135	SEG[34]	-931	-409
136	SEG[35]	-862	-409
137	SEG[36]	-793	-409
138	SEG[37]	-724	-409
139	SEG[38]	-655	-409
140	SEG[39]	-585	-409
141	SEG[40]	-516	-409
142	SEG[41]	-447	-409
143	SEG[42]	-378	-409
144	SEG[43]	-309	-409
145	SEG[44]	-240	-409
146	SEG[45]	-171	-409
147	SEG[46]	-102	-409
148	SEG[47]	-33	- 4 09
149	SEG[48]	36	-409
150	SEG[49]	106	-409
151	SEG[50]	175	-409
152	SEG[51]	244	-409
153	SEG[51]	313	-409
154	SEG[52]	382	-409
155	SEG[53]	451	-409
156	SEG[55]	520	-409
100	OLO[JJ]	520	+∪∂

PAD	PIN Name	х	Υ
No.	riiv ivaille	^	1
157	SEG[56]	589	-409
158	SEG[57]	658	-409
159	SEG[58]	727	-409
160	SEG[59]	797	-409
161	SEG[60]	866	-409
162	SEG[61]	935	-409
163	SEG[62]	1004	-409
164	SEG[63]	1073	-409
165	SEG[64]	1142	-409
166	SEG[65]	1211	-409
167	SEG[66]	1280	-409
168	SEG[67]	1349	-409
169	SEG[68]	1418	-409
170	SEG[69]	1488	-409
171	SEG[70]	1557	-409
172	SEG[71]	1626	-409
173	SEG[72]	1695	-409
174	SEG[73]	1764	-409
175	SEG[74]	1833	-409
176	SEG[75]	1902	-409
177	SEG[76]	1971	-409
178	SEG[77]	2040	-409
179	SEG[78]	2109	-409
180	SEG[79]	2179	-409
181	SEG[80]	2248	-409
182	SEG[81]	2317	-409
183	SEG[82]	2386	-409
184	SEG[83]	2455	-409
185	SEG[84]	2524	-409
186	SEG[85]	2593	-409
187	SEG[86]	2662	-409
188	SEG[87]	2731	-409
189	SEG[88]	2800	-409
190	SEG[89]	2870	-409
191	SEG[90]	2939	-409
192	SEG[91]	3008	-409
193	SEG[92]	3077	-409
194	SEG[93]	3146	-409
195	SEG[94]	3215	-409
196	SEG[95]	3284	-409
197	COM[16]	3529	-409
198	COM[17]	3529	-340
199	COM[18]	3529	-271
200	COM[19]	3529	-202
201	COM[20]	3529	-133
202	COM[21]	3529	-64
203	COM[22]	3529	6
204	COM[23]	3529	75
205	COM[24]	3529	144
206	COM[25]	3529	213
207	COM[26]	3529	282
208	COM[27]	3529	351
	[]		

ST7533 Pad Center Coordinates (1/17 Duty)

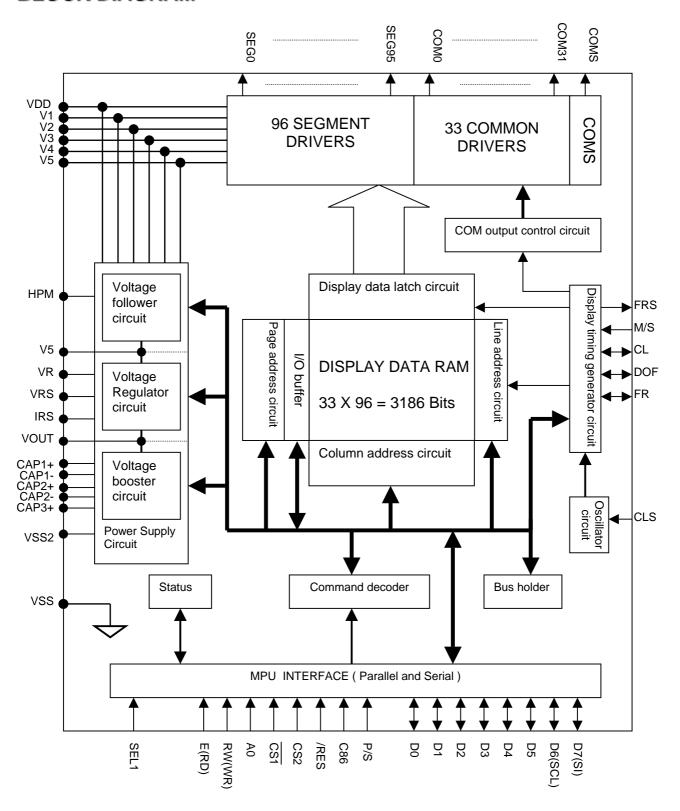
	Center	Coordii	1 ale5 (1
PAD	PIN Name	х	Υ
No.			-
1	COM[12]	3290	409
2	COM[13]	3221	409
3	COM[14]	3152	409
4	COM[15]	3083	409
5	COMS1	3014	409
6	FRS	2919	414
7	FR	2843	414
8	CL	2767	414
9	/DOF	2691	414
10	VSS	2614	414
11	/CS1	2538	414
12	CS2	2462	414
13	VDD	2386	414
14	/RES	2310	414
15	A0	2234	414
16	VSS	2157	414
17	/WR(R/W)	2081	414
18	/RD(E)	2005	414
19	VDD	1929	414
20	D0	1853	414
21	D1	1777	414
22	D2	1701	414
23	D3	1624	414
24	D4	1548	414
25	D5	1472	414
26	D6	1396	414
27	D7	1320	414
28	VDD	1244	414
29	VDD	1168	414
30	VDD	1091	414
31	VSS	1015	414
32	VSS	939	414
33	VSS2	863	414
34	VSS2	787	414
	VOUT	_	414
35		711	414
36	VOUT	634	414
37	CAP3-	558	
38	CAP3-	482	414
39	CAP1+	406	414
40	CAP1+	330	414
41	CAP1-	254	414
42	CAP1-	178	414
43	CAP2-	101	414
44	CAP2-	25	414
45	CAP2+	-51	414
46	CAP2+	-127	414
47	VSS	-203	414
48	VSS	-279	414
49	VRS	-355	414
50	VDD	-432	414
51	VDD	-508	414
52	V1	-584	414

PAD			
No.	PIN Name	Х	Υ
53	V1	-660	414
54	V2	-736	414
55	V2	-812	414
56	V3	-889	414
57	V3	-965	414
58	V4	-1041	414
59	V4	-1117	414
60	V5	-1193	414
61	V5	-1269	414
62	VR	-1345	414
63	VDD	-1422	414
64	VDD	-1498	414
65	TEST0	-1571	414
66	TEST1	-1642	414
67	TEST2	-1713	414
68	TEST3	-1784	414
69	TEST4	-1855	414
70	TEST5	-1926	414
71	VDD	-2000	414
72	M/S	-2076	414
73	CLS	-2152	414
74	VSS	-2228	414
75	C86	-2305	414
76	P/S	-2381	414
77	VDD	-2457	414
78	/HPM	-2533	414
79	VSS	-2609	414
80	IRS	-2685	414
81	VDD	-2762	414
82	SEL1	-2838	414
83	VSS	-2914	414
84	Reserve	-3011	409
85	Reserve	-3080	409
86	Reserve	-3150	409
87	Reserve	-3219	409
88	Reserve	-3288	409
89	Reserve	-3529	351
90	Reserve	-3529	282
91	Reserve	-3529	213
92	COM[7]	-3529	144
93	COM[6]	-3529	75
94	COM[5]	-3529	6
95	COM[4]	-3529	-64
96	COM[3]	-3529	-133
97	COM[2]	-3529	-202
98	COM[1]	-3529	-271
99	COM[0]	-3529	-340
100	COMS2	-3529	-409
101	SEG[0]	-3280	-409
102	SEG[1]	-3211	-409
103	SEG[2]	-3142	-409
104	SEG[3]	-3073	-409

PAD	PIN Name	х	Υ
No. 105	SEG[4]	-3004	-409
106	SEG[5]	-2935	-409
107	SEG[6]	-2866	-409
108	SEG[7]	-2797	-409
109	SEG[8]	-2728	-409
110	SEG[9]	-2658	-409
111	SEG[10]	-2589	-409
112	SEG[10]	-2520	-409
113	SEG[12]	-2451	-409
114	SEG[12]	-2382	-409
115	SEG[14]	-2313	-409
116	SEG[14]	-2244	-409
117		-2175	-409
118	SEG[16]	-2106	
	SEG[17]		-409
119	SEG[18]	-2037	-409
120	SEG[19]	-1967	-409
121	SEG[20]	-1898	-409
122	SEG[21]	-1829	-409
123	SEG[22]	-1760	-409
124	SEG[23]	-1691	-409
125	SEG[24]	-1622	-409
126	SEG[25]	-1553	-409
127	SEG[26]	-1484	-409
128	SEG[27]	-1415	-409
129	SEG[28]	-1346	-409
130	SEG[29]	-1276	-409
131	SEG[30]	-1207	-409
132	SEG[31]	-1138	-409
133	SEG[32]	-1069	-409
134	SEG[33]	-1000	-409
135	SEG[34]	-931	-409
136	SEG[35]	-862	-409
137	SEG[36]	-793	-409
138	SEG[37]	-724	-409
139	SEG[38]	-655	-409
140	SEG[39]	-585	-409
141	SEG[40]	-516	-409
142	SEG[41]	-447	-409
143	SEG[42]	-378	-409
144	SEG[43]	-309	-409
145	SEG[44]	-240	-409
146	SEG[45]	-171	-409
147	SEG[46]	-102	-409
148	SEG[47]	-33	-409
149	SEG[48]	36	-409
150	SEG[49]	106	-409
151	SEG[50]	175	-409
152	SEG[51]	244	-409
153	SEG[52]	313	-409
154	SEG[53]	382	-409
155	SEG[54]	451	-409
156	SEG[55]	520	-409
100	ودعاوعا	020	700

PAD	PIN Name	Х	Υ
No.	Fild Idaille	^	•
157	SEG[56]	589	-409
158	SEG[57]	658	-409
159	SEG[58]	727	-409
160	SEG[59]	797	-409
161	SEG[60]	866	-409
162	SEG[61]	935	-409
163	SEG[62]	1004	-409
164	SEG[63]	1073	-409
165	SEG[64]	1142	-409
166	SEG[65]	1211	-409
167	SEG[66]	1280	-409
168	SEG[67]	1349	-409
169	SEG[68]	1418	-409
170	SEG[69]	1488	-409
171	SEG[70]	1557	-409
172	SEG[71]	1626	-409
173	SEG[72]	1695	-409
174	SEG[73]	1764	-409
175	SEG[74]	1833	-409
176	SEG[75]	1902	-409
177	SEG[76]	1971	-409
178	SEG[77]	2040	-409
179	SEG[78]	2109	-409
180	SEG[79]	2179	-409
181	SEG[80]	2248	-409
182	SEG[81]	2317	-409
183	SEG[82]	2386	-409
184	SEG[83]	2455	-409
185	SEG[84]	2524	-409
186	SEG[85]	2593	-409
187	SEG[86]	2662	-409
188	SEG[87]	2731	-409
189	SEG[88]	2800	-409
190	SEG[89]	2870	-409
191	SEG[90]	2939	-409
192	SEG[91]	3008	-409
193	SEG[92]	3077	-409
194	SEG[93]	3146	-409
195	SEG[94]	3215	-409
196	SEG[95]	3284	-409
197	Reserve	3529	-409
198	Reserve	3529	-340
199	Reserve	3529	-271
200	Reserve	3529	-202
201	Reserve	3529	-133
202	Reserve	3529	-64
203	Reserve	3529	6
204	Reserve	3529	75
205	COM[8]	3529	144
206	COM[9]	3529	213
207	COM[10]	3529	282
208	COM[11]	3529	351
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BLOCK DIAGRAM



ST7533 PIN DESCRIPTIONS

Power Supply Pins

Pin Name	1/0	Function	No. of Pins
VDD	Power Supply	Shared with the MPU power supply terminal Vcc.	12
VSS	Power Supply	This is a 0V terminal connected to the system GND.	9
VSS2	Power Supply	This is the reference power supply for the step-up voltage circuit for the liquid crystal drive.	2
VRS	Power Supply	This is the internal-output VREG power supply for the LCD power supply voltage regulator.	1
V1, V2, V3, V4, V5	Power Supply	This is a multi-level power supply for the liquid crystal drive. The voltage Supply applied is determined by the liquid crystal cell, and is changed through the use of a resistive voltage divided or through changing the impedance using an op. amp. Voltage levels are determined based on VDD, and must maintain the relative magnitudes shown below. $ \text{VDD} \ (= \text{V0}) \ge \text{V1} \ge \text{V2} \ge \text{V3} \ge \text{V4} \ge \text{V5} $ When the power supply turns ON, the internal power supply circuits produce the V1 to V4 voltages shown below. The voltage settings are selected using the LCD bias set command.	10

LCD Power Supply Pins

Pin Name	I/O	Function	No. of Pins
CAP1+	0	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1- terminal.	2
CAP1-	0	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1+ terminal.	2
CAP2+	0	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2- terminal.	2
CAP2-	0	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2+ terminal.	2
CAP3-	0	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1+ terminal.	2
VOUT	0	DC/DC voltage converter. Connect a capacitor between this terminal and VSS.	2
VR	I	Output voltage regulator terminal. Provides the voltage between VDD and V5 through a resistive voltage divider. IRS = "L": the V5 voltage regulator internal resistors are not used. IRS = "H": the V5 voltage regulator internal resistors are used.	2

System Bus Connection Pins

Pin Name	I/O				Function			No. of Pi	ns
D5 to D0 D6 (SCL) D7 (SI)	I/O	This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit standard MPU data bus. When the serial interface is selected (P/S = "L"): D7: serial data input (SI); D6: the serial clock input (SCL). D0 to D5 are set to high impedance. When the chip select is not active, D0 to D7 are set to high impedance.						8	
A0	I	This and A0 =	is conne it determ = "H": Ind	ect to the least sign ines whether the d icates that D0 to D cates that D0 to D	ificant bit of t ata bits are c 7 are display	he normal MF lata or a comr data.	U address bus,	1	
/RES	I			s set to "L," the set	_			1	
/CS1 CS2	I			nip select signal. Wecomes active, and				2	
/RD (E)	I	(E) ⁻ ST7 • Wh	 When connected to an 8080 MPU, this is active LOW. (E) This pin is connected to the /RD signal of the 8080 MPU, and the ST7533 series data bus is in an output status when this signal is "L". When connected to a 6800 Series MPU, this is active HIGH. This is the 6800 Series MPU enable clock input terminal. 					1	
/WR (R/W)	I	(R/V) the of • Wh This Whe	 When connected to an 8080 MPU, this is active LOW. (R/W) This terminal connects to the 8080 MPU/WR signal. The signals on the data bus are latched at the rising edge of the /WR signal. When connected to a 6800 Series MPU: This is the read/write control signal input terminal. When R/W = "H": Read. When R/W = "L": Write. 						
C86	I	C86	This is the MPU interface switch terminal. C86 = "H": 6800 Series MPU interface. C86 = "L": 8080 MPU interface.					1	
		P/S P/S	This is the parallel data input/serial data input switch terminal. P/S = "H": Parallel data input. P/S = "L": Serial data input. The following applies depending on the P/S status:						
			P/S	Data/Command	Data	Read/Write	Serial Clock		
P/S	I		"H"	A0	D0 to D7	/RD, /WR	Х	1	
			"L"	A0	SI (D7)	Write only	SCL (D6)		
		/RD	(E) and I	"L", D0 to D5 fixed WR (R/W) are fixe ata input, It is impo	d to either "H	l" or "L".	1.		

Pin Name	I/O		Function							
CLS	I	oscillator circu CLS = "H" : us CLS = "L" : us When CLS = " This terminal se Master operation slave operation Synchronizing	Ferminal to select whether or enable or disable the display clock internal oscillator circuit. CLS = "H": used Internal oscillator circuit. CLS = "L": used external clock input. (internal oscillator is disable) When CLS = "L", input the display clock through the CL terminal. This terminal selects the master/slave operation for the ST7533 Series chips. Waster operation outputs the timing signals that are required for the LCD display, while slave operation input the timing signals required for the liquid crystal display, Synchronizing the liquid crystal display system. W/S = "H" Master operation							
M/S	1	M/S = "L" Slave	Oscillator	Power Supply	CL	FR	FRS	DOF	1	
		"H" "H"	Circuit Enabled Disabled		Output Input	Output Output	Output Output	Output Output		
		"L" "H"	l.	Disabled	Input Input	Input Input	Output Output	Input Input		
CL	I/O	This is the dis The following M/S CLS "H" "H" "L" "H" "L"	is true dep	ending on		and CLS s	tatus.		1	
FR	0	This is the liqu	This is the liquid crystal alternating current signal terminal.							
/DOF	0	This is the LC	D blanking	control ter	minal.				1	
FRS	0	This is the out This terminal and is used in	s only ena	bled when	the static	indicator	display is	ON	1	
IRS	I	This terminal: IRS = "H": Uso IRS = "L": Do	selects the the interr	resistors for all resistors internal re	or the V5 s esistors. T	voltage le	Itage leve	is	1 al	
/HPM	I	drive. /HPM = "H": N	regulated by an external resistive voltage divider attached to the VR terminal This is the power control terminal for the power supply circuit for liquid crystal drive. /HPM = "H": Normal mode /HPM = "L": High power mode						al 1	
SEL1	I	These pins ar SEL 1 0	1	DUTY 1/33 1/17	1/5 c	AS or 1/6 or 1/6			1	
TEST0 ~ 5	ı	These are terr TEST0 (PAD TEST1 ~ 5 mg	No.65) mu	st connect	to VDD				6	;

LCD Driver Pins

Pin Name	I/O				Funct	ion			No. of Pins	
		CC	These are the LCD segment drive outputs. Through a combination of the contents of the display RAM and with the FR signal, a single level is selected from VDD, V2, V3, and V5.							
			D 4 14 D 4 T 4		Ou	tput V	/oltage]		
SEG0			RAM DATA	FR	Normal Disp	ay	Reverse Display			
to	0		Н	Н	VDD		V2	1	96	
SEG95			Н	L	V5		V3			
			L	Н	V ₂		VDD			
			L	L	V3		V5			
					Power save		Vı		D	
		T	Part No.	CD con	nmon drive outpu	1	TAL			
				33 DUTY COM		M0 ~ COM31	+	32		
			17 DUTY	17 DUTY COM		1	6			
COM0			Through a combination of the contents of the scan data and with the FR signal, a single level is selected from VDD, V1, V4, and V5.							
COMn	0		Scan Data	FR	Output Voltag	е				
			Н	Н	V5					
			Н	L	VDD					
			L	Н	V ₁					
			L	L	V4					
			Power save		VDD					
COMS	0	th	These are the COM output terminals for the indicator. Both terminals output the same signal. Leave these open if they are not used.						2	

DESCRIPTION OF FUNCTIONS

The MPU Interface

Selecting the Interface Type

With the ST7533 chips, data transfers are done through an 8-bit parallel data bus (D7 to D0) or through a serial data input (SI). Through selecting the P/S terminal polarity to the

"H" or "L" it is possible to select either parallel data input or serial data input as shown in Table 1.

Table 1

P/S	/CS1	CS2	Α0	/RD	/WR	C86	D7	D6	D5~D0
H: Parallel Input	/CS1	CS2	A0	/RD	/WR	C86	D7	D6	D5~D0
L: Serial Input	/CS1	CS2	A0	_	_	_	SI	SCL	(HZ)

[&]quot;-" indicates fixed to either "H" or to "L"

The Parallel Interface

When the parallel interface has been selected (P/S ="H"), then it is possible to connect directly to either an

8080-system MPU or a 6800 Series MPU (shown in Table 2) by selecting the C86 terminal to either "H" or to "L".

Table 2

C86 (P/S=H)	/CS1	CS2	Α0	/RD	/WR	D7~D0
H: 6800 Series	/CS1	CS2	A0	Е	R/W	D7~D0
L: 8080 Series	/CS1	CS2	A0	/RD	/WR	D7~D0

Moreover, data bus signals are recognized by a combination of A0, /RD (E), /WR (R/W) signals, as shown in Table 3.

Table 3

Shared	6800 Series	8080	Series	Function	
A0	R/W	/RD	/WR	Function	
1	1	0	1	Reads the display data	
1	0	1	0	Writes the display data	
0	1	0	1	Status read	
0	0	1	0	Write control data (command)	

The Serial Interface

When the serial interface has been selected (P/S = "L") then when the chip is in active state (/CS1 = "L" and CS2 = "H") the serial data input (SI) and the serial clock input (SCL) can be received. The serial data is read from the serial data input pin in the rising edge of the serial clocks D7, D6 through D0, in this order. This data is converted to 8 bits parallel data in the rising edge of the eighth serial clock for the processing.

The A0 input is used to determine whether or the serial data input is display data or command data; when A0 = `H'', the data is display data, and when A0 = `L'' then the data is command data. The A0 input is read and used for detection every 8th rising edge of the serial clock after the chip becomes active. Figure 1 is a serial interface signal chart.

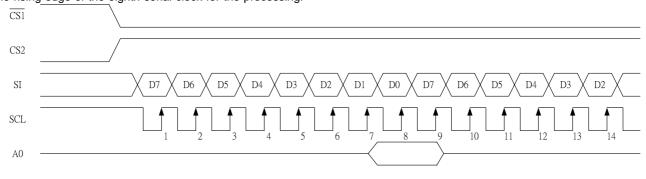


Figure 1

- * When the chip is not active, the shift registers and the counter are reset to their initial states.
- * Reading is not possible while in serial interface mode.
- * Caution is required on the SCL signal when it comes to line-end reflections and external noise. We recommend that operation be rechecked on the actual equipment.

The Chip Select

The ST7533 have two chip select terminals: /CS1 and CS2. The MPU interface or the serial interface is enabled only when /CS1 = "L" and CS2 = "H".

When the chip select is inactive, D0 to D7 enter a high impedance state, and the A0, /RD, and /WR inputs are inactive. When the serial interface is selected, the shift register and the counter are reset.

The Accessing the Display Data RAM and the Internal Registers

Data transfer at a higher speed is ensured since the MPU is required to satisfy the cycle time (tcyc) requirement alone in accessing the ST7533. Wait time may not be considered. And, in the ST7533, each time data is sent from the MPU, a type of pipeline process between LSIs is performed through the bus holder attached to the internal data bus. Internal data bus.

For example, when the MPU writes data to the display data RAM, once the data is stored in the bus holder, then it is written to the display data RAM before the next data write cycle. Moreover, when the MPU reads the display data RAM,

the first data read cycle (dummy) stores the read data in the bus holder, and then the data is read from the bus holder to the system bus at the next data read cycle.

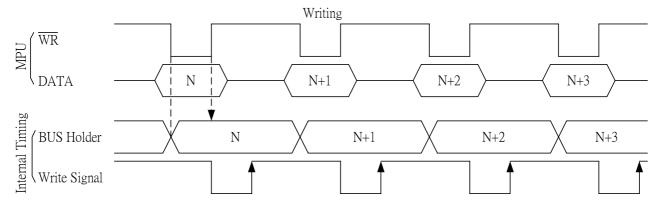
There is a certain restriction in the read sequence of the display data RAM. Please be advised that data of the specified address is not generated by the read instruction issued immediately after the address setup. This data is generated in data read of the second time. Thus, a dummy read is required whenever the address setup or write cycle operation is conducted.

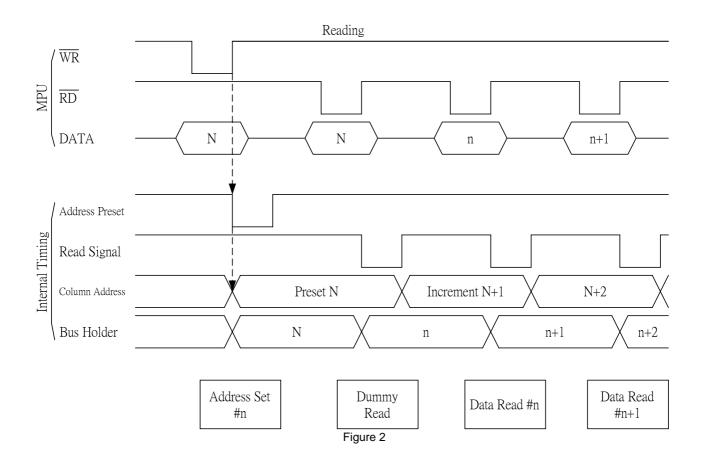
This relationship is shown in Figure 2.

The Busy Flag

When the busy flag is "1" it indicates that the ST7533 is running internal processes, and at this time no command aside from a status read will be received. The busy flag is outputted to D7 pin with the read instruction. If the cycle time

(tcyc) is maintained, it is not necessary to check for this flag before each command. This makes vast improvements in MPU processing capabilities possible.





Display Data RAM

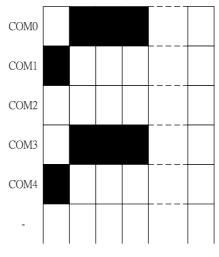
The display data RAM stores the dot data for the LCD. It has a 33 (4 page x 8 bit +1) x 96 bit structure.

as is shown in Figure 3, the D7 to D0 display data from the MPU corresponds to the LCD display common direction, there are few constraints at the time of display data transfer when multiple ST7533 are used, thus and display structures can be created easily and with a high degree of freedom.

	, .			9	9	
D0	0	1	1	1		0
D1	1	0	0	0		0
D2	0	0	0	0		0
D3	0	1	1	1		0
D4	1	0	0	0		0
-						

Display data RAM

Moreover, reading from and writing to the display RAM from the MPU side is performed through the I/O buffer, which is an independent operation from signal reading for the liquid crystal driver. Consequently, even if the display data RAM is accessed asynchronously during liquid crystal display, it will not cause adverse effects on the display (such as flickering).



Liquid crystal display

Figure 3

The Page Address Circuit

Page address of the display data RAM is specified through the Page Address Set Command. The page address must be specified again when changing pages to perform access. Page address 8 (D3, D2, D1, D0 = 1, 0, 0, 0) is a special RAM for icons, and only display data D0 is used. (see Figure 4)

The Column Addresses

The display data RAM column address is specified by the Column Address Set command. The specified column address is incremented (+1) with each display data read/write command. This allows the MPU display data to be accessed continuously. Moreover, the incrementing of column addresses stops with 5FH. Because the column address is independent of the page address, when moving, for example, from page 0 column 5FH to page 1 column 00H,

it is necessary to respecify both the page address and the column address.

Furthermore, as is shown in Table 4, the ADC command (segment driver direction select command) can be used to reverse the relationship between the display data RAM column address and the segment output. Because of this, the constraints on the IC layout when the LCD module is assembled can be minimized. As is shown in Figure 4,

Table 4

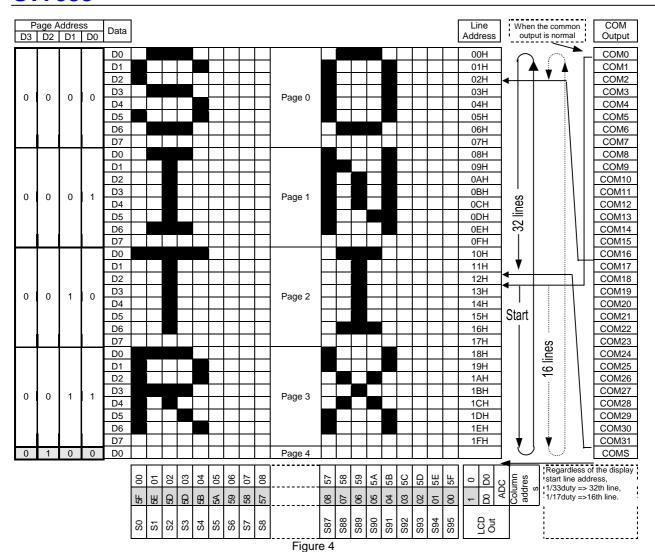
SEG Output ADC	SEG0		SEG 95
(D0) "0"	0 (H)	\rightarrow Column Address \rightarrow	5F(H)
(D0) "1"	5F(H)	\leftarrow Column Address \leftarrow	0 (H)

The Line Address Circuit

The line address circuit, as shown in Table 4, specifies the line address relating to the COM output when the contents of the display data RAM are displayed. Using the display start line address set command, what is normally the top line of the display can be specified (this is the COM0 output when the common output mode is normal, and the COM31 output

for ST7533, the detail is shown page.11 The display area is a 33 line area for the ST7533.

If the line addresses are changed dynamically using the display start line address set command, screen scrolling, page swapping, etc. can be performed.



The Display Data Latch Circuit

The display data latch circuit is a latch that temporarily stores the display data that is output to the liquid crystal driver circuit from the display data RAM.

Because the display normal/reverse status, display ON/OFF

status, and display all points ON/OFF commands control only the data within the latch, they do not change the data within the display data RAM itself.

The Oscillator Circuit

This is a CR-type oscillator that produces the display clock. The oscillator circuit is only enabled when M/S= "H" and CLS = "H".

When CLS = "L" the oscillation stops, and the external clock is input through the CL terminal.

Display Timing Generator Circuit

The display timing generator circuit generates the timing signal to the line address circuit and the display data latch circuit using the display clock. The display data is latched into the display data latch circuit synchronized with the display clock, and is output to the data driver output terminal. Reading to the display data liquid crystal driver circuits is completely independent of accesses to the display data RAM by the MPU. Consequently, even if the display data RAM is

accessed asynchronously during liquid crystal display, there is absolutely no adverse effect (such as flickering) on the display.

Moreover, the display timing generator circuit generates the common timing and the liquid crystal alternating current signal (FR) from the display clock. It generates a drive wave form using a 2 frame alternating current drive method, as is shown in Figure 5, for the liquid crystal drive circuit.

Two-frame alternating current drive waveform

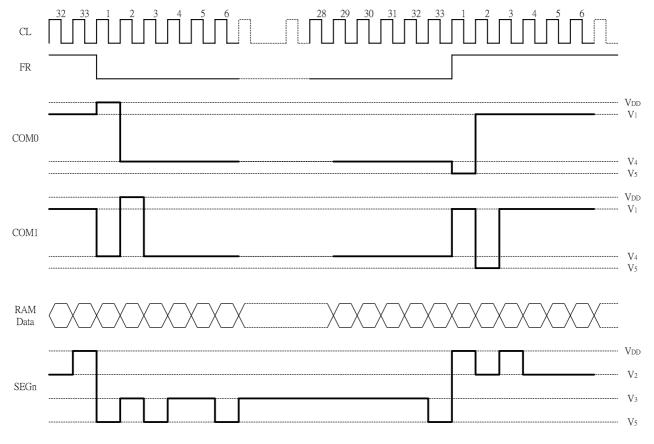


Figure 5

The Common Output Status Select Circuit

In the ST7533 chips, the COM output scan direction can be selected by the common output status select command.

(See Table 6.) Consequently, the constraints in IC layout at the time of LCD module assembly can be minimized.

Table 6

Status	COM Scar	Direction
Status	1/33 DUTY	1/17 DUTY
Normal		COM0 → COM15
Reverse	COM31 → COM0	COM15 → COM0

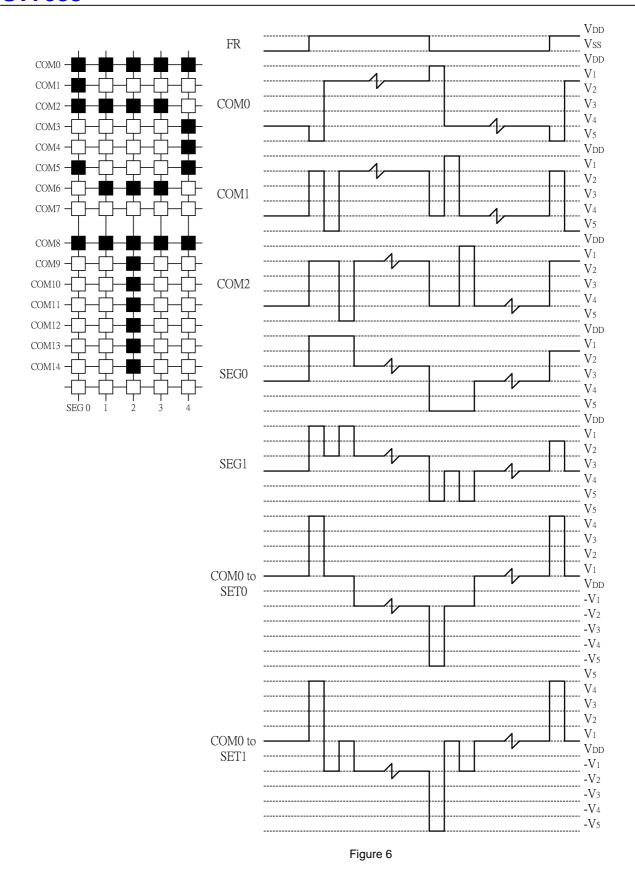
Durte	Com		com[0:15] Common output pins com[16:31]										
Duty	dir	0 1 2 3 4 5 6 7	8 9 10 11 12 13 14 15	9 10 11 12 13 14 15 16 17 18 19 20 21 22 23 24 25 26 27 28 2									
1/33	0	com[0:7]	com[8:15]	com[16:23]	com[23:31]	coms							
1/33	1	com[31:23]	com[31:23] com[23:16] com[15:8]		com[7:0]	coms							
1/17	0	com[0:7]	rese	erve	com[8:15]	coms							
1/1/	1	com[15:8]	rese	erve	com[7:0]	coms							

The LCD Driver Circuits

These are a 129-channel, that generate four voltage levels for driving the LCD . The combination of the display data, the COM scan signal, and the FR signal produces the liquid

crystal drive voltage output.

Figure-6 shows examples of the SEG and COM output wave form.



The Power Supply Circuits

The power supply circuits are low-power consumption power supply circuits that generate the voltage levels required for the LCD drivers. They are Booster circuits, voltage regulator circuits, and voltage follower circuits. They are only enabled in master operation. The power supply circuits can turn the Booster circuits, the voltage regulator circuits, and the

voltage follower circuits ON or OFF independently through the use of the Power Control Set command. Consequently, it is possible to make an external power supply and the internal power supply function somewhat in parallel. Table 7 shows the Power Control Set Command 3-bit data control function, and Table 8 shows reference combinations.

Table 7

bit	function	Status "1" "0"
D2 D1 D0	Booster circuit control bit Voltage regulator circuit control bit (V/R circuit) Voltage follower circuit control bit (V/F circuit)	ON OFF ON OFF ON OFF

The Control Details of Each Bit of the Power Control Set Command

Table 8

Use Settings	D2	D1	D0		Voltage regulator	Voltage follower	External voltage input	Step-up voltage
Only the internal power supply is used	1	1	1	ON	ON	ON	VSS2	Used
Only the voltage regulator circuit and the voltage follower circuit are used	0	1	1	OFF	ON	ON	Vout, Vss2	Open
Only the V/F circuit is used	0	0	1	OFF	OFF	ON	V5, Vss2	Open
Only the external power supply is used	0	0	0	OFF	OFF	OFF	V1 to V5	Open

Reference Combinations

The Step-up Voltage Circuits

Using the step-up voltage circuits equipped within the ST7533 chips it is possible to product a 2X,3X or 4X step-up of the V_{DD} – V_{SS2} voltage levels.

- 4X step-up: Connect capacitor C1 between CAP1+ and CAP1-, between CAP2+ and CAP2-, between CAP1+ and CAP3-, and between Vss2 and VouT, to produce a voltage level in the negative direction at the VouT terminal that is 4 times the voltage level between VDD and Vss2.
- 3X step-up: Connect capacitor C1 between CAP1+ and CAP1-, between CAP2+ and CAP2- and between Vss2 and Vout, and short and short between CAP3- and Vout to produce a voltage level in the negative direction at the Vout terminal that is 3 times the voltage difference between VDD and Vss2.
- 2X step-up: Connect capacitor C1 between CAP1+ and CAP1-, and between Vss2 and Vout, leave CAP2+ open, and short between CAP2-, CAP3- and Vout to produce a voltage in the negative direction at the Vout terminal that Is twice the voltage between VDD and Vss2.

The step-up voltage relationships are shown in Figure 7

^{*} The "step-up system terminals" refer CAP1+, CAP1-, CAP2+, CAP2-, and CAP3-.

^{*} While other combinations, not shown above, are also possible, these combinations are not recommended because they have no practical use.

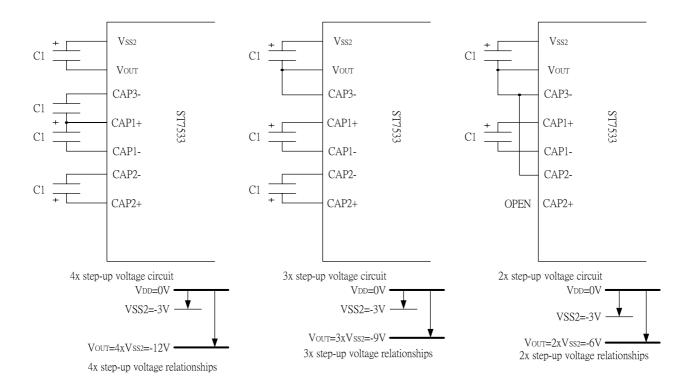


Figure 7

The Voltage Regulator Circuit

The step-up voltage generated at VOUT outputs the LCD driver voltage vs through the voltage regulator circuit. Because the ST7533 chips have an internal high-accuracy fixed voltage power supply with a 64-level electronic volume

function and internal resistors for the V5 voltage regulator, systems can be constructed without having to include high-accuracy voltage regulator circuit components. (VREG thermal gradients approximate -0.15%/°C)

^{*} The Vss2 voltage range must be set so that the VouT terminal voltage does not exceed the absolute maximum rated value.

The Voltage Regulator Circuit

The step-up voltage generated at VOUT outputs the LCD driver voltage V5 through the voltage regulator circuit. Because the ST7533 chips have an internal high-accuracy fixed voltage power supply with a 64-level electronic volume

function and internal resistors for the V5 voltage regulator, systems can be constructed without having to include high-accuracy voltage regulator circuit components. (VREG thermal gradients approximate -0.15%/°C)

(A) When the V5 Voltage Regulator Internal Resistors Are Used

Through the use of the V5 voltage regulator internal resistors and the electronic volume function the liquid crystal power supply voltage V5 can be controlled by commands alone (without adding any external resistors), making it possible to

adjust the liquid crystal display brightness. The V5 voltage can be calculated using equation A-1 over the range where $|V_5| < |V_{OUT}|$.

$$V_{5} = \left(1 + \frac{Rb}{Ra}\right) \bullet V_{EV}$$

$$= \left(1 + \frac{Rb}{Ra}\right) \bullet \left(1 - \frac{\alpha}{162}\right) \bullet V_{REG}$$

$$\left[\because V_{EV} = \left(1 - \frac{\alpha}{162}\right) \bullet V_{REG}\right]$$

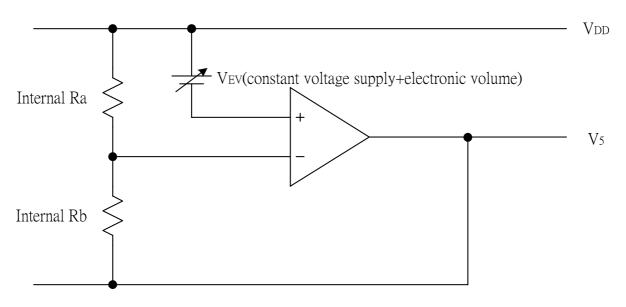


Figure 8

VREG is the IC-internal fixed voltage supply, and its voltage at Ta = 25°C is as shown in Table 9.

Table 9

Part no.	Equipment Type	Thermal Gradient	VREG
ST7533	Internal Power Supply	−0.15 %/°C	-2.1V

 α is set to 1 level of 64 possible levels by the electronic volume function depending on the data set in the 6-bit electronic volume register. Table 10 shows the value for α depending on the electronic volume register settings.

Rb/Ra is the V5 voltage regulator internal resistor ratio, and can be set to 8 different levels through the V5 voltage regulator internal resistor ratio set command. The (1 + Rb/Ra) ratio assumes the values shown in Table 11 depending on the 3-bit data settings in the V5 voltage regulator internal resistor ratio register.

Table 10

D5	D4	D3	D2	D1	D0	α
0	0	0	0	0	0	63
0	0	0	0	0	1	62
0	0	0	0	1	0	61
						:
						:
1	1	1	1	0	1	2
1	1	1	1	1	0	1
1	1	1	1	1	1	0

V5 voltage regulator internal resistance ratio register value and (1 + Rb/Ra) ratio (Reference value)

Table 11

Re	egist	er	ST7533
D2	D1	D0	(1) -0.15 %/°C
0	0	0	3.0
0	0	1	3.5
0	1	0	4.0
0	1	1	4.5
1	0	0	5.0
1	0	1	5.5
1	1	0	6.0
1	1	1	6.5

Figures 9, 10 show V5 voltage measured by values of the internal resistance ratio resistor for V5 voltage adjustment and electric volume resister for each temperature grade model.

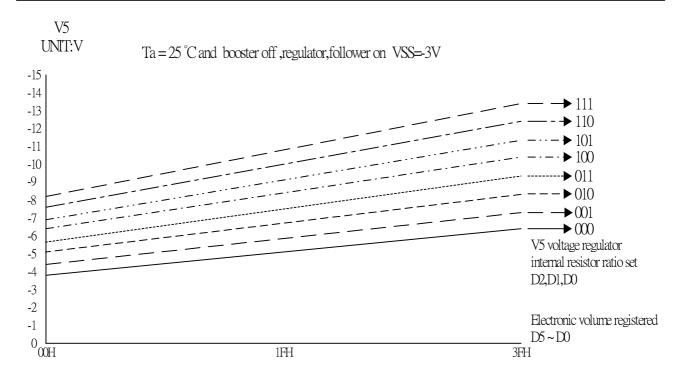


Figure 9 : (1) For ST7533 the Thermal Gradient = -0.15%°C The V₅ voltage as a function of the V₅ voltage regulator internal resistor ratio register and the electronic volume register.

Setup example: When selecting $Ta = 25^{\circ}C$ and $V_5 = -7V$ for an ST7533 on which Temperature gradient = $-0.15\%/^{\circ}C$. Using Figure 9 and the equation A-1, the following setup is enabled.

At this time, the variable range and the notch width of the V5 voltage is, as shown Table 13, as dependent on the electronic volume.

Table	e 12	<u>∍ 12</u>											
Contents	Register												
Contents	D5	D4	D3	D2	D1	D0							
For V ₅ voltage regulator	_			- 0	1	0							
Electronic Volume	1	0	0	1	0	1							

Table 13

V5	Min	Тур	Max	Units
Variable Range	-8.4 (63 levels)	-7.0 (central value)	-5.1 (0 level)	[V]
Notch width		51		[mV]

(B) When an External Resistance is Used (The V5 Voltage Regulator Internal Resistors Are Not Used) (1)

The liquid crystal power supply voltage V5 can also be set without using the V5 voltage regulator internal resistors (IRS terminal = "L") by adding resistors Ra' and Rb' between VDD and VR, and between VR and V5, respectively. When this is done, the use of the electronic volume function makes it possible to adjust the brightness of the liquid crystal display

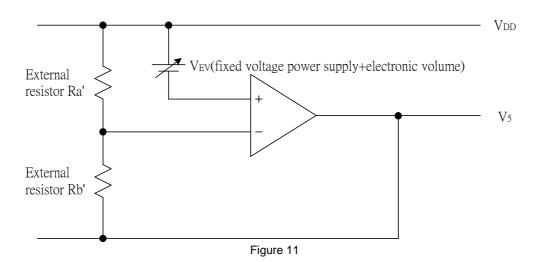
by controlling the liquid crystal power supply voltage V₅ through commands.

In the range where | V5 | < | VOUT |, the V5 voltage can be calculated using equation B-1 based on the external resistances Ra' and Rb'.

$$V_{5} = \left(1 + \frac{Rb'}{Ra'}\right) \bullet V_{EV}$$

$$= \left(1 + \frac{Rb'}{Ra'}\right) \bullet \left(1 - \frac{\alpha}{162}\right) \bullet V_{REG}$$

$$\left[\because V_{EV} = \left(1 - \frac{\alpha}{162}\right) \bullet V_{REG}\right]$$



Setup example: When selecting Ta = 25° C and V₅ = -7 V for ST7533 the temperature gradient = -0.15%/°C. When the central value of the electron volume register is (D5, D4, D3, D2, D1, D0) = (1, 0, 0, 0, 0, 0), then α = 31 and $V_{REG} = -2.1V$ so, according to equation B-1,

$$V_5 = \left(1 + \frac{Rb'}{Ra'}\right) \bullet \left(1 - \frac{\alpha}{162}\right) \bullet V_{REG}$$

$$-7V = \left(1 + \frac{Rb'}{Ra'}\right) \bullet \left(1 - \frac{31}{162}\right) \bullet (-2.1)$$

Moreover, when the value of the current running through Ra' and Rb' is set to 5 uA,

$$R\alpha' + Rb' = 1.4M\Omega$$

(Equation B-3)

Consequently, by equations B-2 and B-3,

$$\frac{Rb'}{Ra'} = 3.12$$

Ra' =
$$340k\Omega$$

Rb' =
$$1060 \text{k} \Omega$$

At this time, the V₅ voltage variable range and notch width, based on the electron volume function, is as given in Table 14.

Table 14		
Тур	Max	Units

(C) When External Resistors are Used (The V5 Voltage Regulator Internal Resistors Are Not Used) (2)

When the external resistor described above are used, adding a variable resistor as well makes it possible to perform fine adjustments on Ra' and Rb', to set the liquid crystal drive voltage V_5 . In this case, the use of the electronic volume function makes it possible to control the liquid crystal power supply voltage V_5 by commands to adjust the liquid

crystal display brightness.

In the range where \mid V5 \mid < \mid VouT \mid the V5 voltage can be calculated by equation C-1 below based on the R1 and R2 (variable resistor) and R3 settings, where R2 can be subjected to fine adjustments (\triangle R2).

$$V_{5} = \left(1 + \frac{R_{3} + R_{2} - \Delta R_{2}}{R_{1} + \Delta R_{2}}\right) \bullet V_{EV}$$

$$= \left(1 + \frac{R_{3} + R_{2} - \Delta R_{2}}{R_{1} + \Delta R_{2}}\right) \bullet \left(1 - \frac{\alpha}{162}\right) \bullet V_{REG}$$

$$\left[\because V_{EV} = \left(1 - \frac{\alpha}{162}\right) \bullet V_{REG}\right]$$

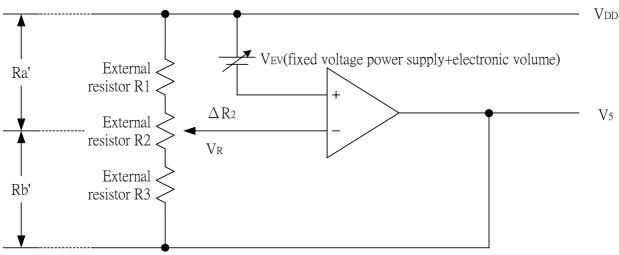


Figure 12

Setup example: When selecting Ta = 25°C and V5 = -5 to -9 V (using R2) for an ST7533 the temperature gradient = -0.15%/°C.

When the central value for the electronic volume register is set at (D5, D4, D3, D2, D1, D0) = (1, 0, 0, 0, 0, 0), then α = 31 and VREG = -2.1 V so, according to equation C-1, when Δ R2 = 0 Ω , in order to make V5 = -9 V,

$$-9V = \left(1 + \frac{R3 + R2}{R1}\right) \bullet \left(1 - \frac{31}{162}\right) \bullet (-2.1)$$

When $\triangle R_2 = R_2$, in order to make V = -5 V

$$-5V = \left(1 + \frac{R3}{R1 + R2}\right) \bullet \left(1 - \frac{31}{162}\right) \bullet (-2.1)$$

When the current flowing VDD and V5 is set to 5 uA,

 R_1 + R_2 + R_3 = 1.4 $M\Omega$ (Equation C-4) With this, according to equation C-2, C-3 and C-4,

$$R1 = 264k\Omega$$

$$R2 = 211k\Omega$$

$$R3 = 925k\Omega$$

The V₅ voltage variable range and notch width based on the electron volume function is as shown in Table 15.

Table 1	1
---------	---

V 5	Min	Тур	Max	Units
Variable Range Notch width	-8.7 (63 levels)	-7.0 (central value) 53	-5.3 (0 level)	[V] [mV]
NOICH WIGHT		55		[IIIV]

- * When the V5 voltage regulator internal resistors or the electronic volume function is used, it is necessary to at least set the voltage regulator circuit and the voltage follower circuit to an operating mode using the power control set commands. Moreover, it is necessary to provide a voltage from Vout when the Booster circuit is OFF.
- * The VR terminal is enabled only when the V5 voltage regulator internal resistors are not used (i.e. the IRS terminal = "L"). When the V5 voltage regulator internal resistors are used (i.e. when the IRS terminal = "H"), then the VR terminal is left open.
- * Because the input impedance of the VR terminal is high, it is necessary to take into consideration short leads, shield cables, etc. to handle noise.

The LCD Voltage Generator Circuit

The V5 voltage is produced by a resistive voltage divider within the IC, and can be produced at the V1, V2, V3, and V4 voltage levels required for liquid crystal driving. Moreover,

when the voltage follower changes the impedance, it provides V1, V2, V3 and V4 to the liquid crystal drive circuit.

High Power Mode

The power supply circuit equipped in the ST7533 chips has very low power consumption (normal mode: HPM = "H"). However, for LCDs or panels with large loads, this low-power power supply may cause display quality to degrade. When this occurs, setting the HPM terminal to "L" (high power mode) can improve the quality of the display. We recommend that

the display be checked on actual equipment to determine whether or not to use this mode. Moreover, if the improvement to the display is inadequate even after high power mode has been set, then it is necessary to add a liquid c r y s t a l d r i v e p o w e r s u p p l y externally.

The Internal Power Supply Shutdown Command Sequence

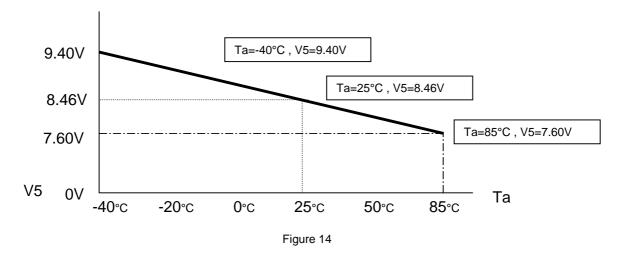
The sequence shown in Figure 13 is recommended for shutting down the internal power supply, first placing the

power supply in power saver mode and then turning the power supply OFF.



Figure 13

The temperature grade of the Internal Power Supply for ST7533 (-0.15%/°C):



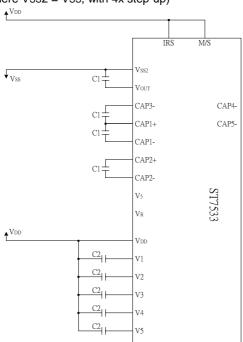
Reference Circuit Examples

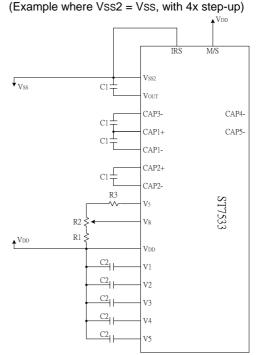
Figure 15 shows reference circuit examples.

- 1. When used all of the step-up circuit, voltage regulating circuit and V/F circuit
- When the voltage regulator internal resistor is used.

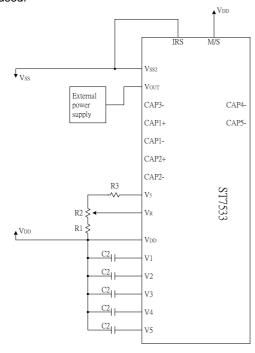
(2) When the voltage regulator internal resistor is not used.

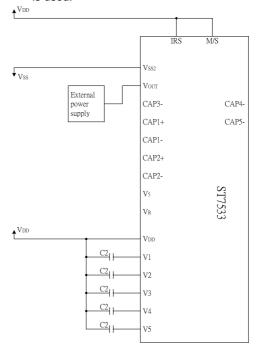
(Example where Vss2 = Vss, with 4x step-up)



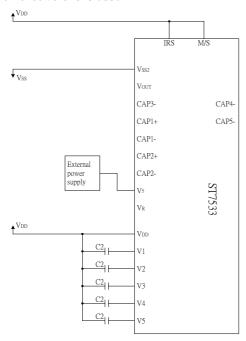


- 2. When the voltage regulator circuit and V/F circuit alone are used
- (1) When the V5 voltage regulator internal resistor is not used.
- (2) When the V5 voltage regulator internal resistor is used.

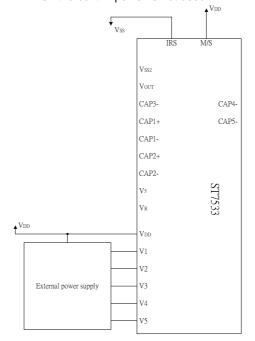




3. When the V/F circuit alone is used

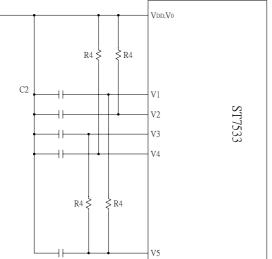


4. When the built-in power is not used



5. When the built-in power circuit is used to drive a liquid crystal panel heavily loaded with AC or DC, it is recommended to connect an external resistor to stabilize

potentials of V1, V2, V3 and V4 which are output from the



built-in voltage follower.

Examples of shared reference settings When V5 can vary between -8 and 12 V

Item	Set value	units
c1	1.0 to 4.7	uF
c2	0.1 to 4.7	uF

C1 and C2 are determined by the size of the LCD being driven

Reference set value R4: $100K\Omega \sim 1M\Omega$ It is recommended to set an optimum resistance value R4 taking the liquid

crystal display and the drive waveform.

Figure 15

- * 1. Because the VR terminal input impedance is high, use short leads and shielded lines.
- * 2. C1 and C2 are determined by the size of the LCD being driven. Select a value that will stabilize the liquid crystal drive voltage.

Example of the Process by which to Determine the Settings:

- Turn the voltage regulator circuit and voltage follower circuit ON and supply a voltage to VOUT from the outside.
- Determine C2 by displaying an LCD pattern with a heavy load (such as horizontal stripes) and selecting a C2 that stabilizes the liquid crystal drive voltages (V1 to V5). Note that all C2 capacitors must have the same capacitance value.
- Next turn all the power supplies ON and determine C1.

The Reset Circuit

When the /RES input comes to the "L" level, these LSIs return to the default state. Their default states are as follows:

- 1. Display OFF
- 2. Normal display
- 3. ADC select: Normal (ADC command D0 = "L")
- 4. Power control register: (D2, D1, D0) = (0, 0, 0)
- 5. Serial interface internal register data clear
- 6. LCD power supply bias rate: 1/33 DUTY = 1/6 bias 1/17 DUTY = 1/5 bias
- All-indicator lamps-on OFF (All-indicator lamps ON/OFF command D0 = "L")
- 8. Power saving clear
- 9. V5 voltage regulator internal resistors Ra and Rb separation
- Output conditions of SEG and COM terminals SEG=VDD, COM=VDD
- 11. Read modify write OFF
- 12. Static indicator OFF Static indicator register : (D1, D2) = (0, 0)
- 13. Display start line set to first line
- 14. Column address set to Address 0
- 15. Page address set to Page 0
- 16. Common output status normal
- 17. V5 voltage regulator internal resistor ratio set mode clear
- 18. Electronic volume register set mode clear Electronic volume register :

(D5, D4, D3, D2, D1, D0) = (1, 0. 0, 0, 0, 0)

19. Test mode clear

On the other hand, when the reset command is used, the above default settings from 11 to 19 are only executed. When the power is turned on, the IC internal state becomes unstable, and it is necessary to initialize it using the /RES terminal. After the initialization, each input terminal should be controlled normally.

Moreover, when the control signal from the MPU is in the high impedance, an over current may flow to the IC. After applying a current, it is necessary to take proper measures to prevent the input terminal from getting into the high impedance state.

If the internal liquid crystal power supply circuit is not used on ST7533, it is necessary that /RES is "H" when the external liquid crystal power supply is turned on. This IC has the function to discharge V5 when /RES is "L," and the external power supply short-circuits to VDD when /RES is "L." While /RES is "L," the oscillator and the display timing generator stop, and the CL, FR, FRS and /DOF terminals are fixed to "H." The terminals D0 to D7 are not affected. The VDD level is output from the SEG and COM output terminals. This means that an internal resistor is connected between VDD and V5.

When the internal liquid crystal power supply circuit is not used on other models of ST7533 series, it is necessary that /RES is "L" when the external liquid crystal power supply is turned on.

While /RES is "L," the oscillator works but the display timing generator stops, and the CL, FR, FRS and /DOF terminals are fixed to "H." The terminals D0 to D7 are not affected.

COMMANDS

The ST7533 identify the data bus signals by a combination of A0, /RD (E), /WR(R/W) signals. Command interpretation and execution does not depend on the external clock, but rather is performed through internal timing only, and thus the processing is fast enough that normally a busy check is not required.

In the 8080 MPU interface, commands are launched by inputting a low pulse to the /RD terminal for reading, and inputting a low pulse to the WR terminal for writing. In the 6800 Series MPU interface, the interface is placed in a read mode when an "H" signal is input to the R/W terminal and placed in a write mode when a "L" signal is input to the R/W terminal and then the command is launched by inputting a high pulse to the E terminal. Consequently, the 6800 Series MPU interface is different than the 80x86 Series MPU interface in that in the explanation of commands and the display commands the status read and display data read /RD (E) becomes "1(H)". In the explanations below the commands are explained using the 8080 Series MPU interface as the example.

When the serial interface is selected, the data is input in sequence starting with D7.

<Explanation of Commands>

Display ON/OFF

This command turns the display ON and OFF.

	E	R/W									
Α0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	Setting
0	1	0	1	0	1	0	1	1	1	1	Display ON Display OFF

When the display OFF command is executed when in the display all points ON mode, power saver mode is entered. See the section on the power saver for details.

Display Start Line Set

This command is used to specify the display start line address of the display data RAM shown in Figure 4. For further details see the explanation of this function in "The Line Address Circuit".

	E	R/W	D7	D6	D5	D4	D3	D2	D1	D0	Line address
Α0	RD	WR									20 444000
0	1	0	0	1	0	0	0	0	0	0	0
						0	0	0	0	1	1
						0	0	0	1	0	2
							1				\downarrow
						1	1	1	1	0	30
						1	1	1	1	1	31

Page Address Set

This command specifies the page address corresponding to the low address when the MPU accesses the display data RAM (see Figure 4). Specifying the page address and column address enables to access a desired bit of the display data RAM. Changing the page address does not accompany a change in the status display.

	E	R/W									
A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	Page address
0	1	0	1	0	1	1	0	0 0 0 0 1	0 0 1 1 0	0 1 0 1	0 1 2 3 4

Column Address Set

This command specifies the column address of the display data RAM shown in Figure 4. The column address is split into two sections (the higher 4 bits and the lower 4 bits) when it is set (fundamentally, set continuously). Each time the display data RAM is accessed, the column address automatically increments (+1), making it possible for the MPU to continuously read from/write to the display data. The column address increment is topped at 5FH. This does not change the page address continuously. See the function explanation in "The Column Address Circuit," for details.

	Α0	E RD	R/W WR	D7	D6	D5	D4	D3	D2	D1	D0	A7	A6	A5	A4	А3	A2	A 1	Α0	Column address
High bits \rightarrow	0	1	0	0	0	0	1	Α7	A6	Α5	A4	0	0	0	0	0	0	0	0	0
Low bits \rightarrow							0	A3	A2	Α1	A0	0	0	0	0	0	0	0	1	1
												0	0	0	0	0	0	1	0	2
																\downarrow				\downarrow
												0	1	0	1	1	1	1	0	94
												0	1	0	1	1	1	1	1	95

Status Read

	E	R/W									
A0	\overline{RD}	WR	D7	D6	D5	D4	D3	D2	D1	D0	
0	0	1	BUSY	ADC	ON/OFF	RESET	0	0	0	0	

BUSY	BUSY = 1: it indicates that either processing is occurring internally or a reset condition is in process. BUSY = 0: A new command can be accepted. if the cycle time can be satisfied, there is no need to check for BUSY conditions.
ADC	This shows the relationship between the column address and the segment driver. 0: Normal (column address n ↔ SEG n) 1: Reverse (column address 95-n ↔ SEG n) (The ADC command switches the polarity.)
ON/OFF	ON/OFF: indicates the display ON/OFF state. 0: Display ON 1: Display OFF (This display ON/OFF command switches the polarity.)
RESET	This indicates that the chip is in the process of initialization either because of a /RES signal or because of a reset command. 0: Operating state 1: Reset in progress

Display Data Write

This command writes 8-bit data to the specified display data RAM address. Since the column address is automatically incremented by "1" after the write, the MPU can write the display data.

	Е	R/W	
Α0	RD	\overline{WR}	D7 D6 D5 D4 D3 D2 D1 D0
1	1	Λ	Write data

Display Data Read

This command reads 8-bit data from the specified display data RAM address. Since the column address is automatically incremented by "1" after the read, the CPU can continuously read multiple-word data. One dummy read is required immediately after the column address has been set. See the function explanation in "Display Data RAM" for the explanation of accessing the internal registers. When the serial interface is used, reading of the display data becomes unavailable.

	E	R/W	
Α0	RD	\overline{WR}	D7 D6 D5 D4 D3 D2 D1 D0

ADC Select (Segment Driver Direction Select)

This command can reverse the correspondence between the display RAM data column address and the segment driver output. Thus, sequence of the segment driver output pins may be reversed by the command. See the column address circuit (Figure 4) for the detail. Increment of the column address (by "1") accompanying the reading or writing the display data is done according to the column address indicated in Figure 4.

	E	R/W									
Α0	\overline{RD}	WR	D7	D6	D5	D4	D3	D2	D1	D0	Setting
0	1	0	1	0	1	0	0	0	0	0 1	Normal Reverse

Display Normal/Reverse

This command can reverse the lit and unlit display without overwriting the contents of the display data RAM. When this is done the display data RAM contents are maintained.

A0	E RD	R/W WR	D7	D6	D5	D4	D3	D2	D1	D0	Setting
0	1	0	1	0	1	0	0	1	1	0	RAM Data "H" LCD ON voltage (normal) RAM Data "L" LCD ON voltage (reverse)

Display All Points ON/OFF

This command makes it possible to force all display points ON regardless of the content of the display data RAM. The contents of the display data RAM are maintained when this is done. This command takes priority over the display normal/reverse command.

	E	R/W									
A0	\overline{RD}	\overline{WR}	D7	D6	D5	D4	D3	D2	D1	D0	Setting
0	1	0	1	0	1	0	0	1	0	0 1	Normal display mode Display all points ON

When the display is in an OFF mode, executing the display all points ON command will place the display in power save mode. For details, see the Power Save section.

LCD Bias Set

This command selects the voltage bias ratio required for the liquid crystal display.

	E	R/W										Select	Status
Α0	\overline{RD}	\overline{WR}		D7	D6	D5	D4	D3	D2	D1	D0	1/33duty	1/17duty
0	1		0	1	0	1	0	0	0	1	0	1/6 bias	1/6 bias
0	1		U								1	1/5 bias	1/5 bias

Read/Modify/Write

This command is used paired with the "END" command. Once this command has been input, the display data read command does not change the column address, but only the display data write command increments (+1) the column address. This mode is maintained until the END command is input. When the END command is input, the column address returns to the address it was at when the read/modify/write command was entered. This function makes it possible to reduce the load on the MPU when there are repeating data changes in a specified display region, such as when there is a blanking cursor.

	E	R/W								
Α0	RD	$\overline{\mathbf{W}}$ R	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	1	0	0	0	0	0

^{*} Even in read/modify/write mode, other commands aside from display data read/write commands can also be used.

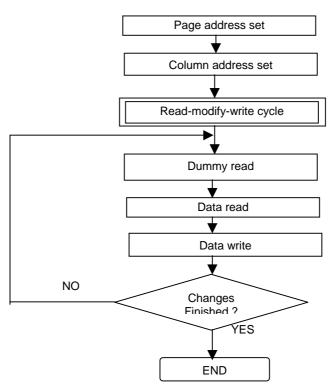


Figure 24 Command Sequence For read modify write

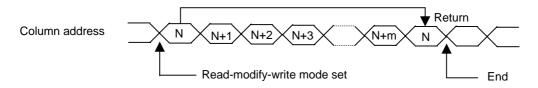


Figure 25

End

This command releases the read/modify/write mode, and returns the column address to the address it was at when the mode was entered

	E	R/W								
Α0	RD	\overline{WR}	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	1	0	1	1	1	0

Reset

This command initializes the display start line, the column address, the page address, the common output mode, the V5 voltage regulator internal resistor ratio, the electronic volume, and the static indicator are reset, and the read/modify/write mode and test mode are released. There is no impact on the display data RAM. See the function explanation in "Reset" for details. The reset operation is performed after the reset command is entered.

	E	R/W								
Α0	RD	\overline{WR}	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	1	0	0	0	1	0

The initialization when the power supply is applied must be done through applying a reset signal to the /RES terminal. The reset command must not be used instead.

Common Output Mode Select

This command can select the scan direction of the COM output terminal. For details, see the function explanation in "Common Output Mode Select Circuit."

	E R/W D7 D6 D5 D4 D3 D2 D1 D0								D 4	Selected Mode						
A0	RD	\overline{WR}	יט	D6	D5	D4	D3	D2	ט1	DÜ		1/33duty	1/17duty			
0	1	Λ	1	1	0	0	0	*	*	*			COM0→COM15			
U		U					1				Reverse	COM31→COM0	COM15→COM0			

^{*} Disabled bit

Power Controller Set

This command sets the power supply circuit functions. See the function explanation in "The Power Supply Circuit," for details

A0	E RD	R/W WR	D7	D6	D5	D4	D3	D2	D1	D0	Selected Mode
			0	0	1	0	1	0 1			Booster circuit: OFF Booster circuit: ON
0	1	0							0 1		Voltage regulator circuit: OFF Voltage regulator circuit: ON
										0 1	Voltage follower circuit: OFF Voltage follower circuit: ON

V5 Voltage Regulator Internal Resistor Ratio Set

This command sets the V5 voltage regulator internal resistor ratio. For details, see the function explanation is "The Voltage Regulator circuit " and table 11 .

A0	E RD	R/W WR	D7	D6	D5	D4	D3	D2	D1	D0	Rb/Ra Ratio
			0	0	1	0	0	0	0	0	Small
								0	0	1	
_		^						0	1	0	
U	1	0							\downarrow		\downarrow
								1	1	1	
								1	1	1	Large

The Electronic Volume (Double Byte Command)

This command makes it possible to adjust the brightness of the liquid crystal display by controlling the LCD drive voltage V5 through the output from the voltage regulator circuits of the internal liquid crystal power supply. This command is a two byte command used as a pair with the electronic volume mode set command and the electronic volume register set command, and both commands must be issued one after the other.

The Electronic Volume Mode Set

When this command is input, the electronic volume register set command becomes enabled. Once the electronic volume mode has been set, no other command except for the electronic volume register command can be used. Once the electronic volume register set command has been used to set data into the register, then the electronic volume mode is released.

	E	R/W								
Α0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0

Electronic Volume Register Set

By using this command to set six bits of data to the electronic volume register, the liquid crystal drive voltage V5 assumes one of the 64 voltage levels.

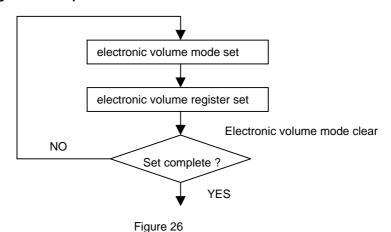
When this command is input, the electronic volume mode is released after the electronic volume register has been set.

Α0	E RD	R/W WR	D7	D6	D5	D4	D3	D2	D1	D0	V 5
			*	*	0	0	0	0	0	1	Small
			*	*	0	0	0	0	1	0	
		0	*	*	0	0	0	0	1	1	
0	1	0					`	l			\downarrow
			*	*	1	1	1	1	1	0	
			*	*	1	1	1	1	1	1	Large

^{*} Inactive bit (set "0")

When the electronic volume function is not used, set this to (1, 0, 0, 0, 0, 0)

The Electronic Volume Register Set Sequence



Static Indicator (Double Byte Command)

This command controls the static drive system indicator display. The static indicator display is controlled by this command only, and is independent of other display control commands.

This is used when one of the static indicator liquid crystal drive electrodes is connected to the FR terminal, and the other is connected to the FRS terminal. A different pattern is recommended for the static indicator electrodes than for the dynamic drive electrodes. If the pattern is too close, it can result in deterioration of the liquid crystal and of the electrodes.

The static indicator ON command is a double byte command paired with the static indicator register set command, and thus one must execute one after the other. (The static indicator OFF command is a single byte command.)

Static Indicator ON/OFF

When the static indicator ON command is entered, the static indicator register set command is enabled. Once the static indicator ON command has been entered, no other command aside from the static indicator register set command can be used. This mode is cleared when data is set in the register by the static indicator register set command.

A0	E RD	R/W WR	D7	D6	D5	D4	D3	D2	D1	D0	Static Indicator
0	1	0	1	0	1	0	1	1	0	0	OFF ON

Static Indicator Register Set

This command sets two bits of data into the static indicator register, and is used to set the static indicator into a blinking mode.

		E	R/W									
	Α0	RD	\overline{WR}	D7	D6	D5	D4	D3	D2	D1	D0	Indicator Display State
Г				*	*	*	*	*	*	0	0	OFF
	0		0							0	1	ON (blinking at approximately one second intervals)
	U	1	U							1	0	ON (blinking at approximately 0.5 second intervals)
										1	1	ON (constantly on)

^{*} Disabled bit (set "0")

Static Indicator Register Set Sequence

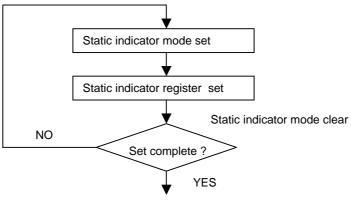


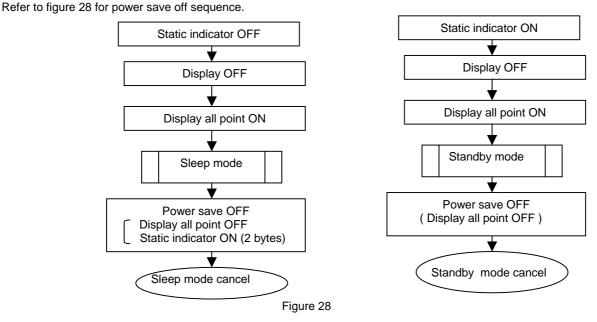
Figure 27

Power Save (Compound Command)

When the display all points ON is performed while the display is in the OFF mode, the power saver mode is entered, thus greatly reducing power consumption.

The power saver mode has two different modes: the sleep mode and the standby mode. When the static indicator is OFF, it is the sleep mode that is entered. When the static indicator is ON, it is the standby mode that is entered.

In the sleep mode and in the standby mode, the display data is saved as is the operating mode that was in effect before the power saver mode was initiated, and the MPU is still able to access the display data RAM.



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Sleep Mode

This stops all operations in the LCD display system, and as long as there are no accesses from the MPU, the consumption current is reduced to a value near the static current. The internal modes during sleep mode are as follows:

- 1. The oscillator circuit and the LCD power supply circuit are halted.
- 2. All liquid crystal drive circuits are halted, and the segment in common drive outputs output a VDD level.

Standby Mode

The duty LCD display system operations are halted and only the static drive system for the indicator continues to operate, providing the minimum required consumption current for the static drive. The internal modes are in the following states during standby mode.

- 1 The LCD power supply circuits are halted. The oscillator circuit continues to operate.
- 2 The duty drive system liquid crystal drive circuits are halted and the segment and common driver outputs output a VDD level. The static drive system does not operate.

When a reset command is performed while in standby mode, the system enters sleep mode.

* When an external power supply is used, it is recommended that the functions of the external power supply circuit be stopped when the power saver mode is started. For example, when the various levels of liquid crystal drive voltage are provided by external resistive voltage dividers, it is recommended that a circuit be added in order to cut the electrical current flowing through the resistive voltage divider circuit when the power saver mode is in effect. The ST7533 series chips have a liquid crystal display blanking control terminal /DOF. This terminal enters an "L" state when the power saver mode is launched. Using the output of /DOF, it is possible to stop the function of an external power supply circuit.

NOP

Non-OPeration Command

	E	R/W								
			DZ	D6	DE	DΔ	D3	D3	D1	DΛ
A0	RD	WR	01	ъ	DS	D 4	D3	DΖ	וט	טט

Test

This is a command for IC chip testing. Please do not use it. If the test command is used by accident, it can be cleared by applying a "L" signal to the /RES input by the reset command or by using an NOP.

	E	R/W								
Α0	RD	\overline{WR}	D7	D6	D5	D4	D3	D2	D1	D0
	4	0	1	1	1	1	1	1	*	*

^{*} Inactive bit

Note: The ST7533 maintain their operating modes until something happens to change them. Consequently, excessive external noise, etc., can change the internal modes of the ST7533. Thus in the packaging and system design it is necessary to suppress the noise or take measure to prevent the noise from influencing the chip. Moreover, it is recommended that the operating modes be refreshed periodically to prevent the effects of unanticipated noise.

Table 16: Table of ST7533 Commands

(Note) *: disabled data

				Cor	nma	nd C	ode)					
Command	Α0	RD	WR	D7	D6	D5	DΔ	DЗ	D2	, D	11	DO	Function
(1) Display ON/OFF	0	1	0	1	0	1	0	1	1		1	0 1	LCD display ON/OFF 0: OFF, 1: ON
(2) Display start line set	0	1	0	0	1	Di	spla	y sta	art a	adc	dre	ss	Sets the display RAM display start line address
(3) Page address set	0	1	0	1	0	1	1	Pa	age	ado	dre	ess	Sets the display RAM page address
(4) Column address set upper bit Column address set lower bit	0	1	0	0	0	0	1	colu Lea	umr ast s	n ad sigr	ddi nifi	cant ress cant ress	Sets the most significant 4 bits of the display RAM column address. Sets the least significant 4 bits of the display RAM column address.
(5) Status read	0	0	1		St	atus		0	C			0	Reads the status data
(6) Display data write	1	1	0			١	Vrite	e da	ta				Writes to the display RAM
(7) Display data read	1	0	1			F	Read	d da	ta				Reads from the display RAM
(8) ADC select	0	1	0	1	0	1	0	0	0)	0	0 1	Sets the display RAM address SEG output correspondence 0: normal, 1: reverse
(9) Display normal/ reverse	0	1	0	1	0	1	0	0	1		1	0 1	Sets the LCD display normal/ reverse 0: normal, 1: reverse
(10) Display all points ON/OFF	0	1	0	1	0	1	0	0	1		0	0 1	Display all points 0: normal display 1: all points ON
(11) LCD bias set	0	1	0	1	0	1	0	0	0)	1	0 1	Sets the LCD drive voltage bias ratio 0: 1/6 bias, 1: 1/5 bias (ST7533)
(12) Read/modify/write	0	1	0	1	1	1	0	0	C)	0	0	Column address increment At write: +1 At read: 0
(13) End	0	1	0	1	1	1	0	1	1		1	0	Clear read/modify/write
(14) Reset	0	1	0	1	1	1	0	0	C)	1	0	Internal reset
(15) Common output mode select	0	1	0	1	1	0	0	0 1	*		*	*	Select COM output scan direction 0: normal direction 1: reverse direction
(16) Power control set	0	1	0	0	0	1	0	1		pe lod		ing	Select internal power supply operating mode
(17) V5 voltage regulator internal resistor ratio set	0	1	0	0	0	1	0	0		esi atio		or	Select internal resistor ratio(Rb/Ra) mode
(18) Electronic volume mode set Electronic volume register set	0	1	0	1 0	0	0 Ele	0 ctro	0 nic v	0 olu/		0 e va	1 alue	Set the V5 output voltage electronic volume register
(19) Static indicator ON/OFF Static indicator	0	1	0	1 0	0	1	0	1			0	0 1 Mode	0: OFF, 1: ON Set the flashing mode
register set (20) Power saver													Display OFF and display all
(21) NOP	0	1	0	1	1	1	0	0	C)	1	1	points ON compound command Command for non-operation
(22) Test	0	1	0	1	1		1	*	*		*	*	Command for IC test. Do not use this command

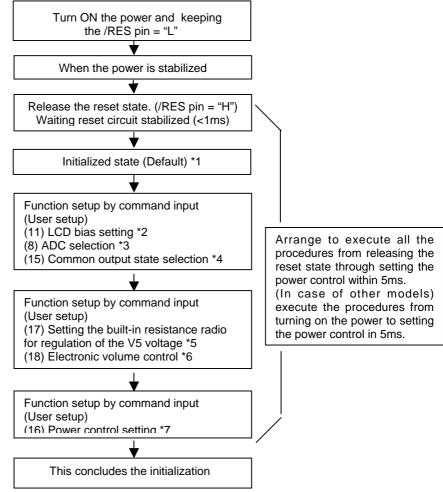
COMMAND DESCRIPTION

Instruction Setup: Reference

(1) Initialization

Note: With this IC, when the power is applied, LCD driving non-selective potentials V2 and V3 (SEG pin) and V4 (COM pin) are output through the LCD driving output pins SEG and COM. When electric charge is remaining in the smoothing capacitor connecting between the LCD driving voltage output pins (V1 ~ V5) and the VDD pin, the picture on the display may become totally dark instantaneously when the power is turned on. To avoid occurrence of such a failure, we recommend the following flow when turning on the power.

1. When the built-in power is being used immediately after turning on the power:

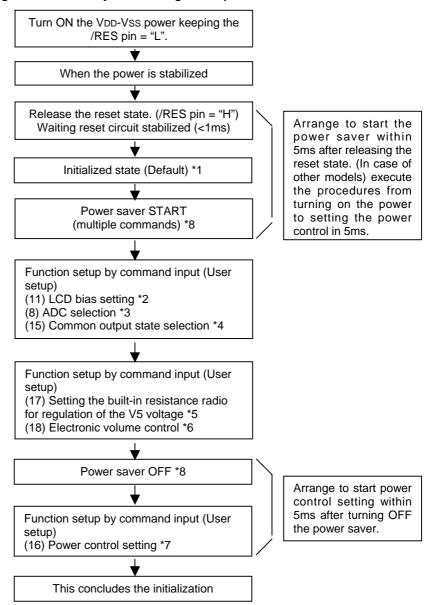


^{*} The target time of 5ms will result to vary depending on the panel characteristics and the capacitance of the smoothing capacitor. Therefore, we suggest you to conduct an operation check using the actual equipment.

Notes: Refer to respective sections or paragraphs listed below.

- *1: Description of functions; Resetting circuit
- *2: Command description; LCD bias setting
- *3: Command description; ADC selection
- *4: Command description; Common output state selection
- *5: Description of functions; Power circuit & Command description; Setting the built-in resistance radio for regulation of the V5 voltage
- *6: Description of functions; Power circuit & Command description; Electronic volume control
- *7: Description of functions; Power circuit & Command description; Power control setting

2. When the built-in power is not being used immediately after turning on the power:

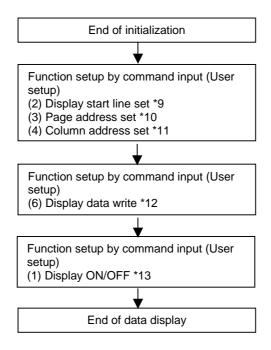


^{*} The target time of 5ms will result to vary depending on the panel characteristics and the capacitance of the smoothing capacitor. Therefore, we suggest you to conduct an operation check using the actual equipment.

Notes: Refer to respective sections or paragraphs listed below.

- *1: Description of functions; Resetting circuit
- *2: Command description; LCD bias setting
- *3: Command description; ADC selection
- *4: Command description; Common output state selection
- *5: Description of functions; Power circuit & Command description; Setting the built-in resistance radio for regulation of the V5 voltage
- *6: Description of functions; Power circuit & Command description; Electronic volume control
- *7: Description of functions; Power circuit & Command description; Power control setting
- *8: The power saver ON state can either be in sleep state or stand-by state. Command description; Power saver START (multiple commands)

(2) Data Display

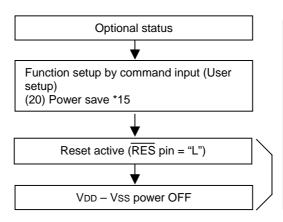


Notes: Reference items

- *9: Command Description; Display start line set
- *10: Command Description; Page address set
- *11: Command Description; Column address set
- *12: Command Description; Display data write
- *13: Command Description; Display ON/OFF

Avoid displaying all the data at the data display start (when the display is ON) in white.

(3) Power OFF *14



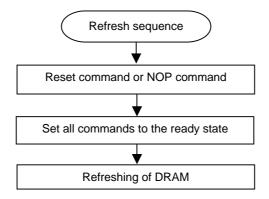
Set the time (t_L) from reset active to turning off the VDD - Vss power (VDD - Vss = 1.8V) longer than the time (t_H) when the potential of V5 ~ V1 becomes below the threshold voltage (approximately 1V) of the LCD panel. For t_H , refer to the <Reference Data> of this event. When t_H is too long, insert a resistor between V5 and VDD to reduce it.

Notes: Reference items

- *14: The logic circuit of this IC's power supply VDD Vss controls the driver of the LCD power supply VDD Vs. So, if the power supply VDD Vss is cut off when the LCD power supply VDD Vs has still any residual voltage, the driver (COM. SEG) may output any uncontrolled voltage. When turning off the power, observe the following basic procedures:
 - After turning off the internal power supply, make sure that the potential V5 ~ V1 has become below the threshold voltage of the LCD panel, and then turn off this IC's power supply (VDD Vss). 6. Description of Function, 6.7 Power Circuit
- *15: After inputting the power save command, be sure to reset the function using the /RES terminal until the power supply VDD Vss is turned off. 7. Command Description (20) Power Save
- *16: After inputting the power save command, do not reset the function using the /RES terminal until the power supply V_{DD} Vss is turned off. 7. Command Description (20) Power Save

Refresh

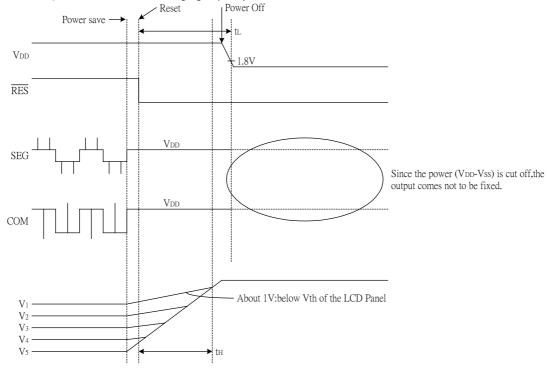
It is recommended to turn on the refresh sequence regularly at a specified interval.



Precautions on Turning off the power

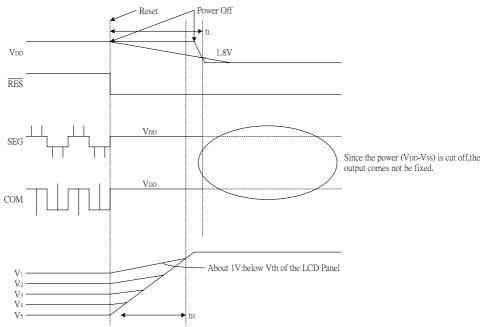
- <Turning the power (VDD VSS) off>
- 1) Power Save (The LCD powers (VDD V5) are off.) → Reset input → Power (VDD VSS) OFF
- Observe $t_L > t_H$.
- When $t_L < t_H$, an irregular display may occur.

Set t_L on the MPU according to the software. t_H is determined according to the external capacity C2 (smoothing capacity of V5 \sim V1) and the driver's discharging capacity.



- <Turning the power (VDD VSS) off : When command control is not possible.> 2) Reset (The LCD powers (VDD VSS) are off.) \rightarrow Power (VDD VSS) OFF
- Observe $t_L > t_H$.
- When $t_L < t_H$, an irregular display may occur.

For t_{L} , make the power (VDD - Vss) falling characteristics longer or consider any other method. t_{H} is determined according to the external capacity C2 (smoothing capacity of V5 to V1) and the driver's discharging capacity.



<Reference Data>

V5 voltage falling (discharge) time (t_H) after the process of operation \rightarrow power save \rightarrow reset. V₅ voltage falling (discharge) time (t_H) after the process of operation \rightarrow reset.

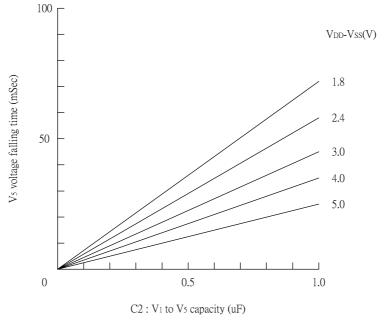


Figure 31

ABSOLUTE MAXIMUM RATINGS

Unless otherwise noted, Vss = 0V

Table 17

Para	meter	Symbol	Conditions	Unit
Power Supply Voltage		VDD	-0.3 ~ +5.0	V
Power supply voltage (VDD	standard)	VSS2	−4.0 ~ -1.8	V
Power supply voltage (VDD	standard)	V5, VOUT	-16.0 ~ +0.3	V
Power supply voltage (VDD	standard)	V1, V2, V3, V4	V5 to +0.3	V
Input voltage		VIN	-0.3 to VDD + 0.3	V
Output voltage		Vo	-0.3 to VDD + 0.3	V
Operating temperature		Topr	-40 to +85	°C
Storage temperature	Bare chip	TSTR	-55 to +125	°C

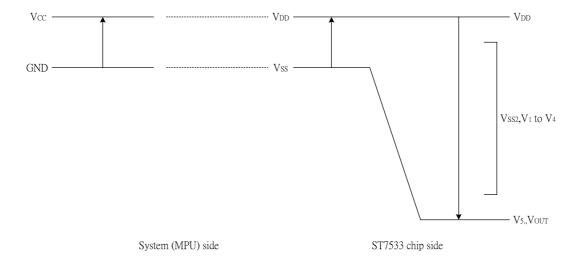


Figure 30

Notes and Cautions

- 1. The Vss2, V1 to V5 and Vout are relative to the VDD = 0V reference.
- 2. Insure that the voltage levels of V1, V2, V3, and V4 are always such that VDD \geq V1 \geq V2 \geq V3 \geq V4 \geq V5.
- 3. Permanent damage to the LSI may result if the LSI is used outside of the absolute maximum ratings. Moreover, it is recommended that in normal operation the chip be used at the electrical characteristic conditions, and use of the LSI outside of these conditions may not only result in malfunctions of the LSI, but may have a negative impact on the LSI reliability as well.

DC CHARACTERISTICS

Unless otherwise specified, Vss = 0 V, $Vdd = 3.0 \text{ V} \pm 10\%$, $Ta = -40 \text{ to } 85^{\circ}\text{C}$

lto		Symbol	Co	ndition		Rating		Units	Applicable
ITE	em	Symbol	Co	ndition	Min.	Тур.	Max.	Units	Pin
Operating	Voltage (1)	Vss			-3.3	_	-1.8	V	Vss*1
Operating	Voltage (2)	Vss2	(Relative	to VDD)	-3.3	_	-1.8	V	Vss2
					-13.0		-4.0		V5 *2
Operating	Voltage (3)	Vss2	(Relative	to VDD)	0.4 x V5	-	VDD	V	V1, V2
					V ₅	_	0.6 x V ₅		V3, V4
High-level Ir	nput Voltage	VIHC			0.8 x VDD	1	VDD	V	*3
Low-level Ir	put Voltage	VILC			Vss		0.2 x VDD	V	*3
High-level O	utput Voltage	Vонс	Іон = −0.5	5 Ма	0.8 x V _{DD}	_	V _{DD}	V	*4
Low-level Ou	utput Voltage	Volc	IOL = 0.5 I	mA	Vss	_	0.2 x VDD	V	*4
Input leaka	age current	lu	VIN = VDD	or Vss	-1.0	_	1.0	μ A	*5
Output leak	age current	ILO	VIN = VDD	or Vss	-3.0		3.0	μ A	*6
Linuid On at	-I Debas ON		Ta = 25°C	V5 = -13.0 V		2.0	3.5		050-
	al Driver ON tance	Ron	(Relative To VDD)	V ₅ = -8.0 V	_	3.2	5.4	ΚΩ	SEGn COMn *7
Static Consun	nption Current	Issq	V ₅ = -13.0	0 V(Relative To	_	0.01	2	μ A	Vss, Vss2
Output Leak	age Current	I5Q	VDD)	` 		0.01	10	μΑ	V5
Input Termina	I Capacitance	CIN	Ta = 25°C	c, f = 1 MHz	_	5.0	8.0	pF	
Oscillator	Internal Oscillator	fosc	1/22 duti	To - 25°C	17	24	27	kHz	*8
Frequency	External Input	fCL	1/33 duly	, Ta = 25°C	17	24	27	kHz	CL

Table 19

	Item	Symbol	Condition		Rating		Units	Applicable
	item	Syllibol	Condition	Min.	Тур.	Max.	Units	Pin
	Input voltage	Vss2	(Relative To V _{DD})	-3.3	_	-1.8	V	Vss2
	Supply Step-up output voltage Circuit	Vout	(Relative To VDD)	-13.0	ı	l	V	Vоит
al Power	Voltage regulator Circuit Operating Voltage	Vout	(Relative To VDD)	-13.0	1	-6.0	٧	Vout
Internal	Voltage Follower Circuit Operating Voltage	V5	(Relative To VDD)	-13.0	l	-4.0	V	V5 * 9
	Base Voltage	VRS	Ta = 25°C , (Relative To VDD) -0.15%/°C	-2.07	-2.10	-2.13	V	*10

• Dynamic Consumption Current : During Display, with the Internal Power Supply OFF Current consumed by total ICs when an external power supply is used .

Table 20

Toot pottorn	Symbol	Condition		Rating		Units	Notes	
Test pattern	Syllibol	Condition	Min.	Тур.	Max.	Units	Notes	
Display Pattern OFF	IDD	VDD = 3.0 V, V5 – VDD = –11.0 V	_	4	12	μΑ	*11	
Display Pattern Checker	IDD	VDD = 3.0 V, V5 – VDD = -11.0 V	_	7	21	μ A	*11	

• Dynamic Consumption Current : During Display, with the Internal Power Supply ON Table 21

Test pattern	Symbol	Condition			Rating		Units	Notes
rest pattern	Зуппоот	Condition		Min.	Тур.	Max.	Ullits	140103
Display	Pattorn (IEEI	VDD = 3.0 V,	Normal Mode	1	70	110		*40
Pattern OFF		Quad step-up voltage. V5 – VDD = –11.0 V	High-Power Mode	_	90	150	μΑ	*12
Display Pattern	Inn	VDD = 3.0 V, Quad step-up voltage.	Normal Mode		95	130	μΑ	*12
Checker IDD		V5 – VDD = –11.0 V	High-Power Mode	_	130	180	μ A	12

• Consumption Current at Time of Power Saver Mode : $VSS = -3.0 \text{ V} \pm 10\%$

Table 22

Item	Symbol	Condition		Rating		Units	Notes
item	Syllibol	Condition	Min.	Тур.	Max.	Ullits	Notes
Sleep mode	IDD	Ta = 25°C	_	0.1	4	., Λ	
Standby Mode	IDD	Ta = 25°C	_	5	10	μ A	

• The Relationship Between Oscillator Frequency fosc, Display Clock Frequency fcL and the Liquid Crystal Frame Rate Frequency fFR

Table 23

	Item	fcL	fFR
1/33 DUTY	Used internal oscillator circuit	fOSC / 8	fOSC / (8*33)
1/33 DUTT	Used external display clock	External input (fcL)	fCL / 264
1/17 DUTY	Used internal oscillator circuit	fOSC / 16	fOSC / (16*17)
1/17 DUTY	Used external display clock	External input (fcL)	fCL / 272

(fFR is the liquid crystal alternating current period, and not the FR signal period.)

References for items market with *

- *1 While a broad range of operating voltages is guaranteed, performance cannot be guaranteed if there are sudden fluctuations to the voltage while the MPU is being accessed.
- *2 The operating voltage range for the VDD system and the V5 system is. This applies when the external power supply is being used.
- *3 The A0, D0 to D5, D6 (SCL), D7 (SI), RD (E), /WR (R/W), /CS1, CS2, CLS, CL, FR, M/S and C86, P/S, /DOF, /RES, IRS, and /HPM terminals.
- *4 The D0 to D7, FR, FRS, /DOF, and CL terminals.
- *5 The A0, /RD (E), /WR (R/W), /CS1, CS2, CLS, M/S, C86, P/S, /RES, IRS, and /HPM terminals.
- *6 Applies when the D0 to D5, D6 (SCL), D7 (SI), CL, FR, and /DOF terminals are in a high impedance state.
- *7 These are the resistance values for when a 0.1 V voltage is applied between the output terminal SEGn or COMn and the various power supply terminals (V₁, V₂, V₃, and V₄). These are specified for the operating voltage (3) range. Ron = 0.1 V $/\Delta I$ (Where ΔI is the current that flows when 0.1 V is applied while the power supply is ON.)
- *8 See Table 23 for the relationship between the oscillator frequency and the frame rate frequency.
- *9 The V5 voltage regulator circuit regulates within the operating voltage range of the voltage follower.
- *10 This is the internal voltage reference supply for the V5 voltage regulator circuit. In the ST7533 , the temperature range approximately -0.15%/°C.
- *11, 12 It indicates the current consumed on ICs alone when the internal oscillator circuit and display are turned on. The ST7533 is 1/5 biased. Does not include the current due to the LCD panel capacity and wiring capacity. Applicable only when there is no access from the MPU.
- *12 It is the value on a ST7533 having the VREG temperature gradient is -0.15%/°C when the V5 voltage regulator internal resistor is used.

TIMING CHARACTERISTICS

System Bus Read/Write Characteristics 1 (For the 8080 Series MPU)

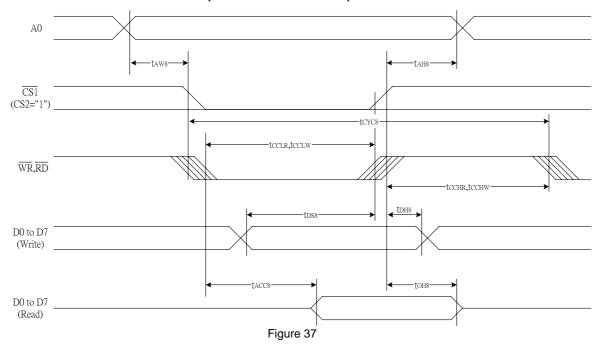


Table 24

 $(V_{DD} = 3.3V, Ta = 25^{\circ}C)$

Item	Cianal	Symbol	Condition	Rat	ing	Units
item	Signal	Symbol	Condition	Min.	Max.	Units
Address hold time		t _{AH8}		0	_	
Address setup time	A0	t _{AW8}		0	_	
System cycle time		tcyc8		240	_	
Enable L pulse width (WRITE)	WR	tcclw		80	_	
Enable H pulse width (WRITE)	VVK	tccнw		80	_	
Enable L pulse width (READ)	RD	tcclr		140	_	ns
Enable H pulse width (READ)	שא	tcchr		80		
WRITE Data setup time		t _{DS8}		40	_	
WRITE Data hold time	D0 to D7	tDH8		10	_	
READ access time	לם טו טם	tacc8	CL = 100 pF	_	70	
READ Output disable time		toн8	CL = 100 pF	5	50	

Table 25

 $(V_{DD} = 2.7 \text{ V}, Ta = 25^{\circ}C)$

Item	Signal	Symbol	Condition	Rat	ing	Units
item	Signal	Symbol	Condition	Min.	Max.	Ullits
Address hold time		tah8		0	_	
Address setup time	A0	t _{AW8}		0	_	
System cycle time		tcyc8		400	_	
Enable L pulse width (WRITE)	WR	tcclw		220	_	
Enable H pulse width (WRITE)		tcchw		180	_	
Enable L pulse width (READ)	RD	tcclr		220	_	ns
Enable H pulse width (READ)	ND	tcchr		180	_	
WRITE Data setup time		t _{DS8}		40	_	
WRITE Data hold time	D0 to D7	tDH8		15	_	
READ access time		tacc8	CL = 100 pF		140	
READ Output disable time		toн8	CL = 100 pF	10	100	

Table 26

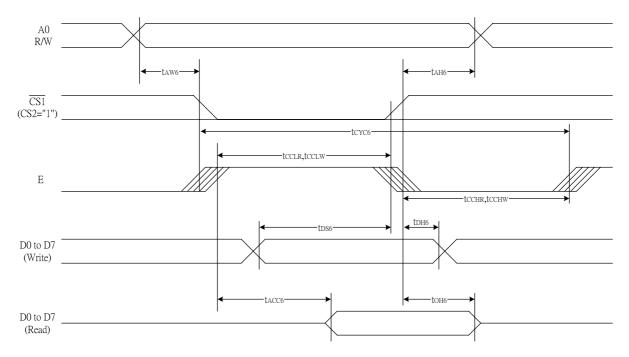
 $(VDD = 1.8V, Ta = 25^{\circ}C)$

Item	Signal	Symbol	Condition	1	ing	Units
item	Signal	Symbol	Condition	Min.	Max.	Units
Address hold time		t _{AH8}		0	_	
Address setup time	A0	t _{AW8}		0	_	
System cycle time		tcyc8		640	_	
Enable L pulse width (WRITE)	WR	tcclw		360	_	
Enable H pulse width (WRITE)	VVIX	tccнw		280	_	
Enable L pulse width (READ)	RD	tcclr		360	_	ns
Enable H pulse width (READ)	, KD	tcchr		280		
WRITE Data setup time		tDS8		80	_	
WRITE Data hold time	D0 to D7	tDH8		30	_	
READ access time	יום טו טם ד	tacc8	CL = 100 pF	_	240	
READ Output disable time		toн8	CL = 100 pF	10	200	

^{*1} The input signal rise time and fall time (t_r , t_f) is specified at 15 ns or less. When the system cycle time is extremely fast, $(t_r + t_f) \le (t_{CYC8} - t_{CCLW} - t_{CCHW})$ for $(t_r + t_f) \le (t_{CYC8} - t_{CCLR} - t_{CCHR})$ are specified.

 $^{^{\}star}2$ All timing is specified using 20% and 80% of VDD as the reference.

^{*3} tccLw and tccLR are specified as the overlap between $\overline{CS1}$ being "L" (CS2 = "H") and \overline{WR} and \overline{RD} being at the "L" level.



System Bus Read/Write Characteristics 2 (For the 6800 Series MPU)

Figure 38

Table 27

		Table	· L 1	$(V_{DD} = 3.3)$	V , Ta = 25	°C)
Item	Signal	Symbol	Condition	Rat	ing	Units
item	Oigilai	Gyllibol	Condition	Min.	Max.	Oiills
Address hold time		tah6		0	_	
Address setup time	A0	taw6		0	_	
System cycle time		tcyc6		240	_	
Enable L pulse width (WRITE)	WR	tewlw		80	_	
Enable H pulse width (WRITE)	VVIX	tewnw		80	_	
Enable L pulse width (READ)	RD	tewlr		80	_	ns
Enable H pulse width (READ)	ND ND	tewhr		140		
WRITE Data setup time		t _{DS6}		40	_	
WRITE Data hold time	D0 to D7	tDH6		10	_	
READ access time	יט טט טט י	tACC6	CL = 100 pF	_	70	
READ Output disable time		toн6	CL = 100 pF	5	50	

Table 28

 $(V_{DD} = 2.7V , Ta = 25^{\circ}C)$

Item	Signal	Symbol	Condition	Rat	ing	Units
item	Signal	Syllibol	Condition	Min.	Max.	Ullits
Address hold time		tah6		0	_	
Address setup time	A0	t _{AW6}		0	_	
System cycle time		tcyc6		400	_	
Enable L pulse width (WRITE)	WR	tewLw		220	_	
Enable H pulse width (WRITE)		tewnw		180	_	
Enable L pulse width (READ)	RD	tewlr		220	_	ns
Enable H pulse width (READ)	KD	tewhr		180	_	
WRITE Data setup time		t _{DS6}		40	_	
WRITE Data hold time	D0 to D7	tDH6		15	_	
READ access time		tacc6	CL = 100 pF		140	
READ Output disable time		toн6	CL = 100 pF	10	100	

Table 29

(VDD =1.8V , Ta =25°C)

Item	Signal	Symbol	Condition	Rat	ing	Units
item	Signal	Symbol	Condition	Min.	Max.	Ullits
Address hold time		t _{AH6}		0	_	
Address setup time	A0	t _{AW6}		0	_	
System cycle time		tcyc6		640	_	
Enable L pulse width (WRITE)	WR	tewLw		360	_	
Enable H pulse width (WRITE)	VVIX	tewnw		280	_	
Enable L pulse width (READ)	RD	tewlr		360	_	ns
Enable H pulse width (READ)	, KD	tewhr		280	_	
WRITE Data setup time		tDS6		80	_	
WRITE Data hold time	D0 to D7	tDH6		30	_	
READ access time	יום טו טם י	tacc6	CL = 100 pF	_	240	
READ Output disable time		toн6	CL = 100 pF	10	200	

^{*1} The input signal rise time and fall time (t_r , t_f) is specified at 15 ns or less. When the system cycle time is extremely fast, $(t_r + t_f) \le (t_{CYC6} - t_{EWLW} - t_{EWHW})$ for $(t_r + t_f) \le (t_{CYC6} - t_{EWLR} - t_{EWHR})$ are specified.

 $^{^{\}star}2$ All timing is specified using 20% and 80% of VDD as the reference.

^{*3} tewlw and tewlr are specified as the overlap between $\overline{CS1}$ being "L" (CS2 = "H") and E.

The Serial Interface

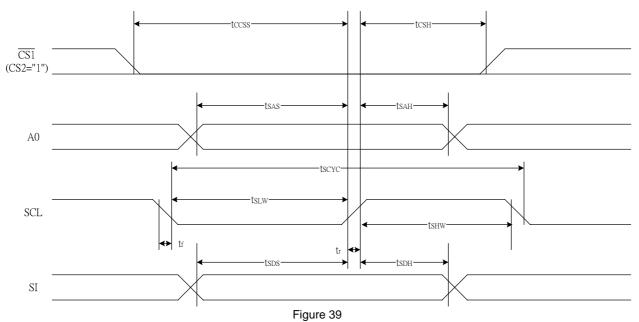


Table 30

 $(VDD = 3.3V, Ta = 25^{\circ}C)$

ltem	Cianal	Cumbal	Condition	Rat	Units	
item	Signal	Symbol	Condition	Min.	Max.	Units
Serial Clock Period		tscyc		50	_	
SCL "H" pulse width	SCL	tshw		25	_	
SCL "L" pulse width		tslw		25	_	
Address setup time	A0	tsas		20	_	
Address hold time	AU	tsah		10	_	ns
Data setup time	SI	tsps		20	_	
Data hold time	Si	tsdh		10	_	
CS-SCL time	CS	tcss		20	_	
CS-SCL time	CS	tcsн		40	_	

Table 31

(VDD =2.7V , Ta =25°C)

Item	Signal	Symbol	Condition	Rating		Units
item	Signal	Syllibol	Condition	Min.	Max.	Ullits
Serial Clock Period		tscyc		100	_	
SCL "H" pulse width	SCL	tshw		50	_	
SCL "L" pulse width		tslw		50	_	
Address setup time	A0	tsas		30	_	
Address hold time	AU	tsah		20	_	ns
Data setup time	SI	tsds		30	_	
Data hold time		tsdн		20	_	
CS-SCL time	CS	tcss		30	_	
CS-SCL time	US	tcsн		60		

Table 32

 $(V_{DD} = 1.8V, Ta = 25^{\circ}C)$

Itam	Cianal	Cumbal	Condition	Rat	ing	Units
Item	Signal	Symbol	Condition	Min.	Max.	Units
Serial Clock Period		Tscyc		200	_	
SCL "H" pulse width	SCL	Tshw		80	_	
SCL "L" pulse width		Tslw		80	_	
Address setup time	40	Tsas		60	_	
Address hold time	A0	Tsah		30	_	ns
Data setup time	SI	Tsds		60	_	
Data hold time	31	Tsdh		30	_	
CS-SCL time	CS	Tcss		40	_	
CS-SCL time	CS	tсsн		100	_	

 $^{^{*}1}$ The input signal rise and fall time (fr, ff) are specified at 15 ns or less. $^{*}2$ All timing is specified using 20% and 80% of VDD as the standard.

Reset Timing

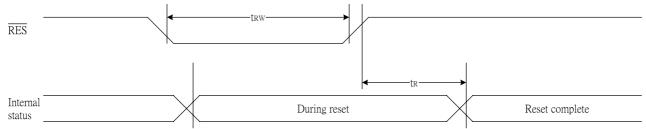


Figure 41

Table 36

 $(VDD = 3.3V, Ta = -40 \text{ to } 85^{\circ}C)$

Item Signal Symbol Condit		Condition	Rating			Units	
item	Signal	Syllibol	Condition	Min.	Тур.	yp. Max.	Units
Reset time		t R		_	_	1.0	uS
Reset "L" pulse width	RES	trw		1.0	-	1	uS

Table 37

 $(V_{DD} = 2.7V, Ta = -40 \text{ to } 85^{\circ}C)$

Item	Cianal	Signal Symbol Condition	Condition		Rating	Units	
item	Signai		Min.	Тур.	Max.		
Reset time		t R		_	_	2.0	uS
Reset "L" pulse width	RES	trw		2.0		_	uS

Table 38

 $(V_{DD} = 1.8V, Ta = -40 \text{ to } 85^{\circ}C)$

Item	Signal	Symbol	Condition	Rating			Units
				Min.	Тур.	Max.	Units
Reset time		t R		_	_	3.0	uS
Reset "L" pulse width	RES	trw		3.0	_	_	uS

 $^{^{*}\}mbox{1}$ All timing is specified with 20% and 80% of VDD as the standard.

THE MPU INTERFACE (REFERENCE EXAMPLES)

The ST7533 Series can be connected to either 80X86 Series MPUs or to 68000 Series MPUs. Moreover, using the serial interface it is possible to operate the ST7533 series chips with fewer signal lines.

The display area can be enlarged by using multiple ST7533 Series chips. When this is done, the chip select signal can be used to select the individual ICs to access.

(1) 8080 Series MPUs

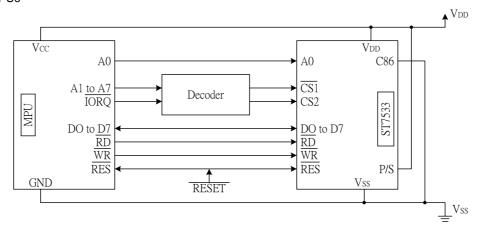


Figure 42-1

(2) 6800 Series MPUs

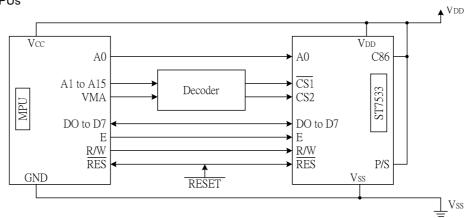


Figure 42-2

(3) Using the Serial Interface

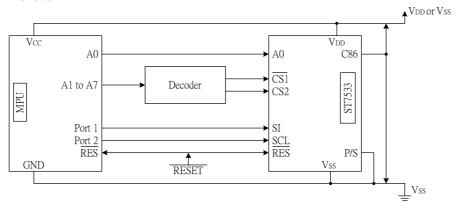


Figure 42-3

CONNECTIONS BETWEEN LCD DRIVERS (REFERENCE EXAMPLE)

The liquid crystal display area can be enlarged with ease through the use of multiple ST7533 Series chips. Use a same equipment type.

(1) ST7533 (master) ↔ ST7533 (slave)

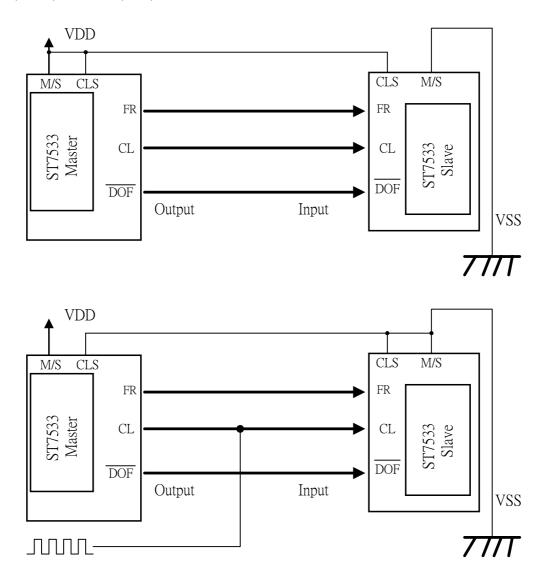


Figure 43-1

(2) Single-chip Structure

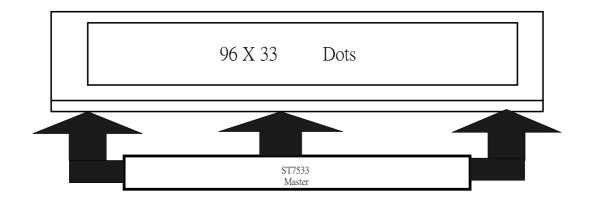
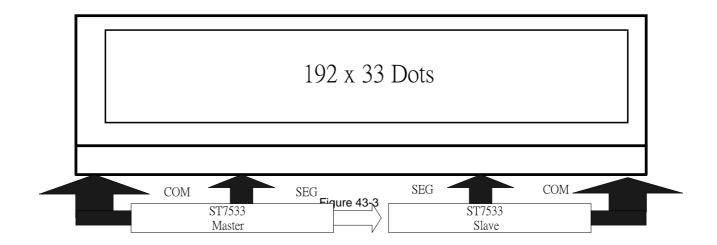


Figure 43-2

(3) Double-chip Structure



ST7533

Revisions

- Version 0.1 Preliminary.
- Version 0.2 update Pad Center Coordinates page 2,3,4.
- Version 0.2a update PIN DESCRIPTIONS M/S.
- Version 0.2b update ABSOLUTE MAXIMUM RATINGS & DC CHARACTERISTICS.
- Version 0.2c update Master and Slave reference example.
- Version 0.3 update Pad Center Coordinates (1/33, 1/17 Duty) page 3,4,5,6 and page-18.
- Version 0.3a update Pad diagram page2 and v5 regulator voltage diagram page24
- Version 0.3b Logic power supply $V_{DD} V_{SS} = 1.8V$ to 3.3V (+10% Range) , $V_{OUT} = -13V$ (+10% Range)
- Version 0.3c Modify page-27 The temperature grade of the Internal Power Supply for ST7533 (-0.05%/°C) Figure 14
- Version 0.3d Delete page-40 Figure 29
- Version 0.4 Modify VRS temperature gradient (-0.15%/°C) and Reset "L" pulse width
- Version 0.5 Delete shipping forms include bare chip and TCP
- Version 0.6 Modify page-10 The TEST0(PAD No.65) must connect VDD
- Version 1.0 Modify Tdh (data hold time) and page41,42 initial flow, datasheet version change version 1.0